1.8V, 1G/2G-bit Serial NAND Flash Memory

MX35UFxG14AC

深圳市满度科技有限公司
Web:www.manduic.com

Tel:150-1290-5940
Email:sales@manduic.com

微信扫码咨询客服

Contents

1. FEATURES 5

2. GENERAL DESCRIPTIONS 6

Figure 1. Logic Diagram 6

3. ORDERING INFORMATION 7

4. BALL ASSIGNMENT AND DESCRIOPTIONS 8

5. PIN DESCRIPTIONS 8

Figure 2. 8-WSON (8x6mm) 8

6. DEVICE OPERATION 9

Figure 3. Serial Mode Supported 9

7. ADDRESS MAPPING 10

8. COMMAND DESCRIPTION 11

Table 1. Command Set 11

8-1. WRITE Operations 12

8-1-1. Write Enable 12

Figure 4. Write Enable (WREN) Sequence 12

8-1-2. Write Disable (04h) 12

Figure 5. Write Disable (WRDI) Sequence 12

8-2. Function Operations 13

8-2-1. GET Functions (0Fh) and SET Features (1Fh) 13

Table 2. Features Settings 13

Figure 6. GET FEATURES (0Fh) Timing 13

Figure 7. SET FEATURES (1Fh) Timing 14

8-3. READ Operations 14

8-3-1. PAGE READ (13h) 14

Table 3. Wrap Address bit Table 14

8-3-2. QE bit 14

Figure 8. PAGE READ (13h) Timing x1 15

Figure 9. RANDOM DATA READ (03h or 0Bh) Timing 16

Figure 10. READ FROM CACHE x 2 17

Figure 11. READ FROM CACHE x 4 18

8-3-3. READ ID (9Fh) 19

Table 4. READ ID Table 19

Figure 12. READ ID (9Fh) Timing 19

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

8-4. Parameter Page 20

8-5. Parameter Page Data Structure Table 21

Table 5. Parameter Page Data Structure (For MX35UF1G14AC) 21

Table 6. Parameter Page Data Structure (For MX35UF2G14AC) 23

8-6. UniqueID Page 25

8-7. Program Operations 25

8-7-1. PAGE PROGRAM 25

Figure 13. PROGRAM LOAD (02h) Timing 26

Figure 14. PROGRAM LOAD RANDOM DATA (84h) Timing 26

8-7-2. QUAD IO PAGE PROGRAM 27

Figure 15. PROGRAM LOAD X4 (32h) Timing 27

Figure 16. QUAD IO PROGRAM RANDOM INPUT (34h) Timing 28

Figure 17. PROGRAM EXECUTE (10h) Timing 29

9. BLOCK OPERATIONS 30

9-1. Block Erase (D8h) 30

Figure 18. Block Erase (BE) Sequence 30

9-2. Feature Register 31

9-2-1. Block Protection Feature 31

Table 7. Definition of Protection Bits 32

9-2-2. Secure OTP (One-Time-Programmable) Feature 33

Table 8. Secure OTP States 33

9-2-3. Status Register 34

Table 9. Status Register Bit Descriptions 34

10. SOFTWARE ALGORITHM 35

10-1. Invalid Blocks (Bad Blocks) 35

Figure 19. Bad Blocks 35

Table 10. Valid Blocks 35

10-2. Bad Block Test Flow 36

Figure 20. Bad Block Test Flow 36

10-3. Failure Phenomena for Read/Program/Erase Operations 36

Table 11. Failure Modes 36

11. DEVICE POWER-UP 37

11-1. Power-up 37

Figure 21. Power On Sequence 37

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

12. PARAMETERS 38

12-1. ABSOLUTE MAXIMUM RATINGS 38

Figure 23. Maximum Negative Overshoot Waveform 38
Table 12. AC Testing Conditions 38
Table 13. Capacitance 38
Table 14. Operating Range 38
Figure 22. Maximum Positive Overshoot Waveform 38
Table 15. DC Characteristics 39
Table 16. General Timing Characteristics 39
Table 17. PROGRAM/READ/ERASE Characteristics 39
Figure 24. WP# Setup Timing and Hold Timing during SET FEATURE when BPRWD=1 40
Figure 25. Serial Input Timing 40
Figure 26. Serial Output Timing 40
Figure 27. Hold Timing 41

13. PACKAGE INFORMATION 42

14. REVISION HISTORY 43

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

1. FEATURES

- 1Gb/2Gb SLC NAND Flash
  - Bus: x4
  - Page size: (2048+64) byte
  - Block size: (128K+4K) byte
- 4-bit ECC/ 528B is required

- **Fast Read Access**
  - Supports Random data read out by x1 x2 & x4 modes, (1-1-1,1-1-2, 1-1-4)[Note 1]
  - Latency of array to register: 25us
  - Frequency: 104MHz
- **Page Program Operation**
  - Page program time: 320us (typ)
- **Block Erase Operation**
  - Block erase time: 1ms (typ.)
- **Single Voltage Operation:**
  - VCC: 1.7 - 1.95V

- **BP bits for block group protection**
- **Low Power Dissipation**
  - Max 30mA
    Active current (Read/Program/Erase)
- **Sleep Mode**
  - 50uA (Max) standby current
- **High Reliability**
  - Program / Erase Endurance: Typical 100K cycles (with 4-bit ECC per (512+16) Byte)
  - Data Retention: 10 years
- **Wide Temperature Operating Range**
  -40°C to +85°C
- **Package:**
  8-WSON (8x6mm)
  All packaged devices are RoHS Compliant and Halogen-free.

Note 1. *Which indicates the number of I/O for command, address and data.*

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

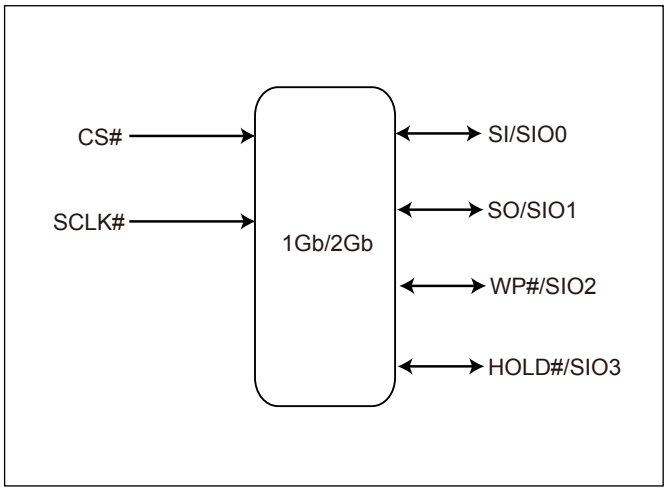
2. GENERAL DESCRIPTIONS

The MX35UFxG14AC is a 1Gb/2Gb SLC NAND Flash memory device with Serial interface.

The memory array of this device adopted the same cell architecture as the parallel NAND, however implementing the industry standard serial interface.

The device needs the micro controller of host side to support 4-bit ECC/528-byte operation.

Figure 1. Logic Diagram

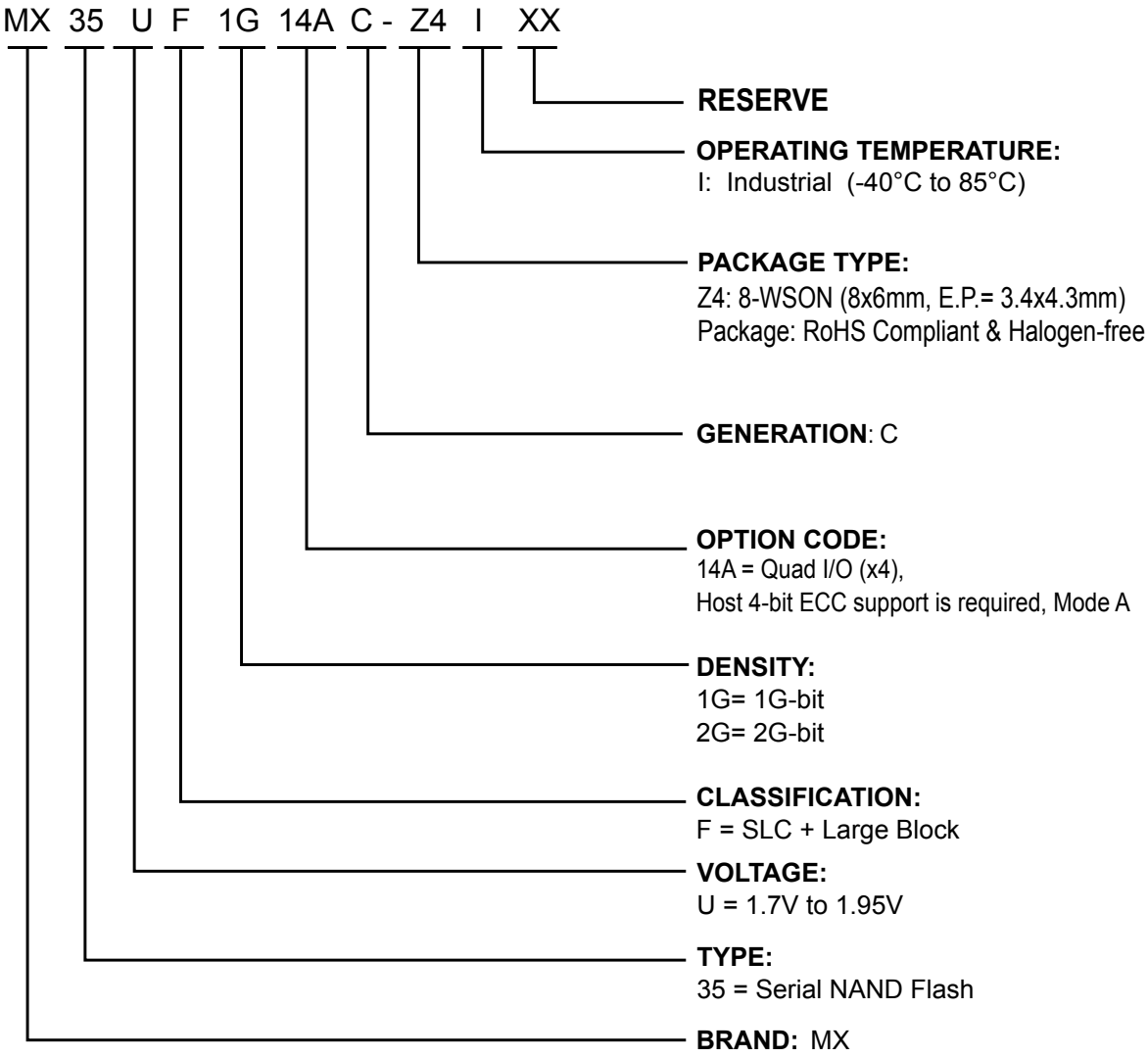


深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

3. ORDERING INFORMATION

Part Name Description

Macronix NAND Flash devices are available in different configurations and densities. Verify valid part numbers by using Macronix's product search at http://www.Macronix.com. Contact Macronix sales for devices not found.



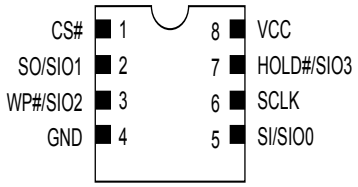
Please contact Macronix regional sales for the latest product selection and available form factors.

Part Number	Density	Organization	VCC Range	Package	Temperature Grade
MX35UF1G14AC-Z4I	1Gb	x4	1.8V	8-WSON	Industrial
MX35UF2G14AC-Z4I	2Gb	x4	1.8V	8-WSON	Industrial

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

4. BALL ASSIGNMENT AND DESCRIOPTIONS

Figure 2. 8-WSON (8x6mm)



5. PIN DESCRIPTIONS

SYMBOL	DESCRIPTION
CS#	Chip Select
SI/SIO0	Serial Data Input (for 1 x I/O)/ Serial Data Input & Output (for 1-1-2 or 1-1-4[note1] read mode)
SO/SIO1	Serial Data Output (for 1 x I/O)/ Serial Data Input & Output (for 1-1-2 or 1-1-4[note1] read mode)
SCLK	Clock Input
WP#/SIO2	Write protection: connect to GND or Serial Data Input & Output (for 1-1-4[note1] read mode)
HOLD#/SIO3	Hold or Serial Data Input & Output (for 1-1-4[note1] read mode)
VCC	+1.8V Power Supply
GND	Ground

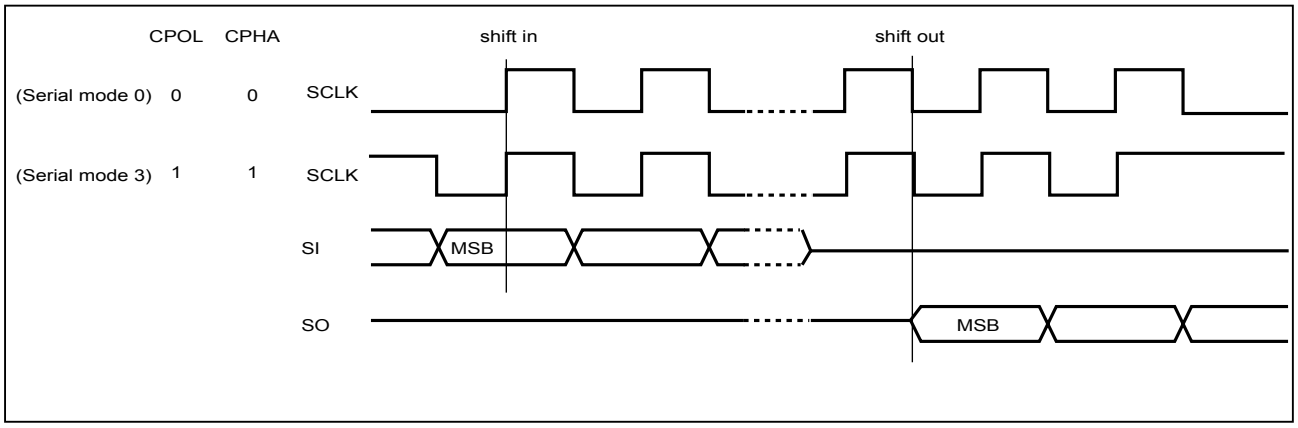
Note 1. *Which indicates the number of I/O for command, address, and data.*

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

6. DEVICE OPERATION

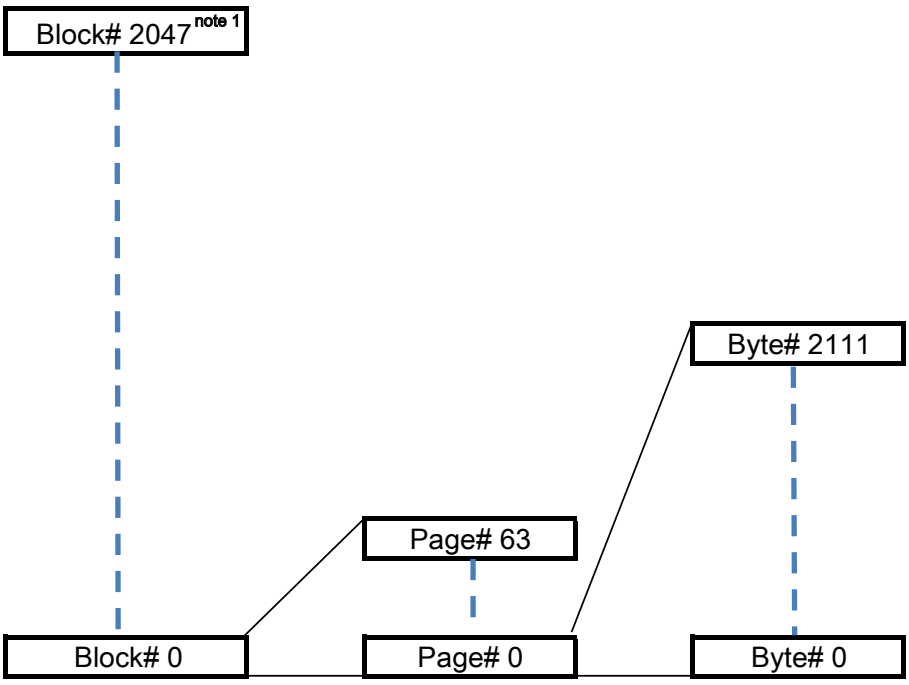
1. Before a command is issued, status register should be checked via get features operations to ensure device is ready for the intended operation.
2. When incorrect command is inputted to this device, this device becomes standby mode and keeps the standby mode until next CS# falling edge. In standby mode, SO pin of this device should be High-Z.
3. When correct command is inputted to this device, this device becomes active mode and keeps the active mode until next CS# rising edge.
4. Input data is latched on the rising edge of Serial Clock (SCLK) and data shifts out on the falling edge of SCLK. The difference of Serial mode 0 and mode 3 is shown as "Serial Modes Supported".
5. During the progress of Write Status Register, Program, Erase operation, to access the memory array is neglected and not affect the current operation of Write Status Register, Program, Erase.

Figure 3. Serial Mode Supported



深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

7. ADDRESS MAPPING



***Note 1**: 2047 for 2Gb, 1023 for 1Gb*
***Note 2**: RA[6] is for plane select, for 2Gb*

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

8. COMMAND DESCRIPTION

Table 1. Command Set

Read/Write Array Commands

Command Type	Get Feature	Set Feature	Page Read	Read From Cache	Read From Cache x2
Command Code	0Fh	1Fh	13h	03h, 0Bh	3Bh
Address Bytes	1	1	3	2	2
Dummy Bytes	0	0	0	1	1
Data Bytes	1	1	0	1 to 2112	1 to 2112
Actions	Get features	Set features	Array read	Output cache data on SO	Output cache data on SI and SO

Command Type	Read From Cache x4	Read ID	Block Erase	Program Execute	Program Load
Command Code	6Bh	9Fh	D8h	10h	02h
Address Bytes	2	0	3	3	2
Dummy Bytes	1	1	0	0	0
Data Bytes	1 to 2112	2	0	0	1 to 2112
Actions	Output cache data on SI, SO, WP#, HOLD#	Read device ID	Block erase	Enter block/page address, no data, execute	Load program data with cache reset first

Command Type	PROGRAM LOAD RANDOM DATA	WRITE ENABLE	WRITE DISABLE	PROGRAM LOAD x4	PROGRAM LOAD RANDOM DATA x4	RESET
Command Code	84h	06h	04h	32h	34h	FFh
Address Bytes	2	0	0	2	2	0
Dummy Bytes	0	0	0	0	0	0
Data Bytes	1 to 2112	0	0	1 to 2112	1 to 2112	0
Actions	Load program data without cache reset			Program Load operation with X4 data input	Program Load random data operation with X4 data input	Reset the device

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

8-1. WRITE Operations

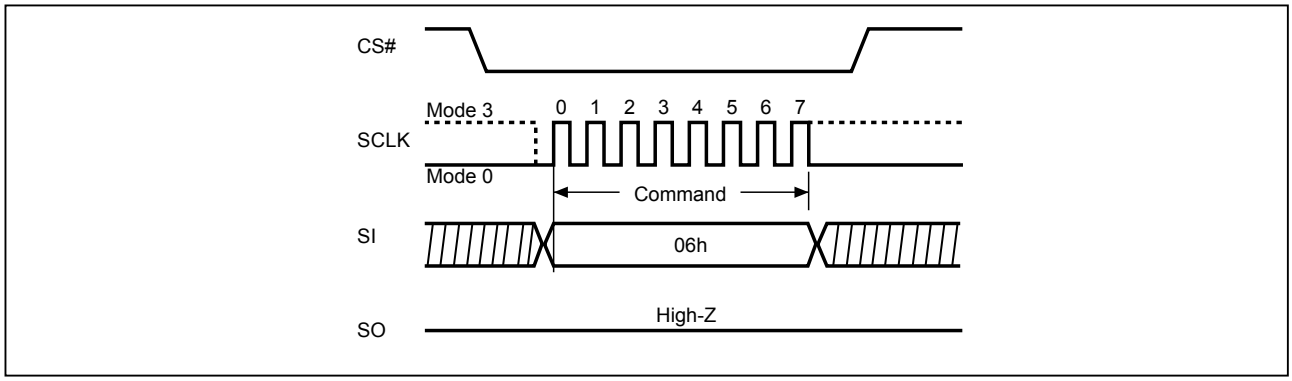
8-1-1. Write Enable

The Write Enable (WREN, 06h) instruction is for setting Write Enable Latch (WEL) bit. For those instructions like Page Program, Secure OTP program, Block Erase, which are intended to change the device content WEL bit should be set every time after the WREN instruction setting the WEL bit.

The sequence of issuing WREN instruction is: CS# goes low→sending WREN instruction code→ CS# goes high.

The WEL bit is reset after the completion of program/erase/secure OTP program operations.

Figure 4. Write Enable (WREN) Sequence



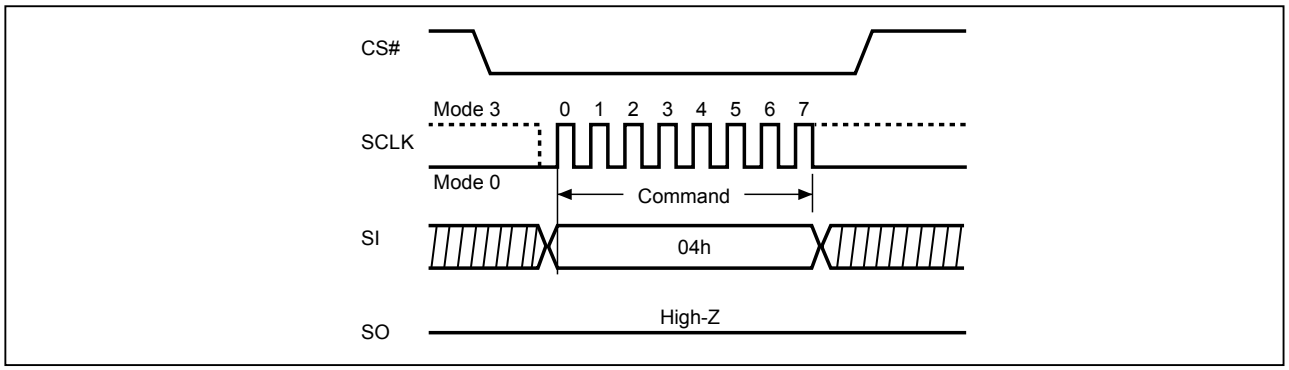
8-1-2. Write Disable (04h)

The Write Disable (WRDI, 04h) instruction is to reset Write Enable Latch (WEL) bit.

The sequence of issuing WRDI instruction is: CS# goes low→sending WRDI instruction code→CS# goes high. It disables the following operations:

- Block Erase
- Secure OTP program
- Page program

Figure 5. Write Disable (WRDI) Sequence



深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

8-2. Function Operations

8-2-1. GET Functions (0Fh) and SET Features (1Fh)

By issuing a one byte address into the function address, the device may then decide if it's a function read or function modification. (0Fh) is for the "GET FEATURE"; (1Fh) is for the "SET FEATURE".

The RESET command (FFh) will not clear the previous feature setting, the feature setting data bits remain until the power is being cycled or modified by the settings in the table below. After a RESET command (FFh) is issued, the Status register OIP bit0 will go high. This bit can be polled to determine when the Reset operation is complete, as it will return to the default value (0) after the reset operation is finished. Issuing the RESET command (FFh) has no effect on the Block Protection and Configuration registers.

The Block Protection and Configuration registers (except "Secure OTP Protect" bit) will return to their default state after a power cycle, and can also be changed using the Set Feature command. Issuing the Get Feature command to read the selected register value will not affect register content.

Table 2. Features Settings

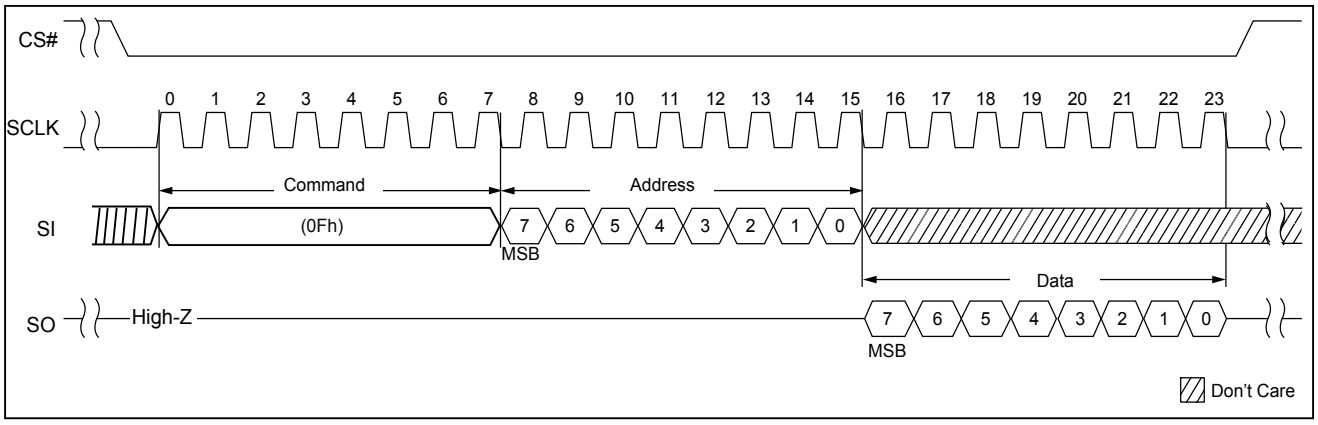
Register	Address	Data Bits							
		bit7	bit6	bit5	bit4	bit3	bit2	bit1	bit0
Configurataion	B0h	Secure OTP Protect	Secure OTP Enable	Reserved	Reserved	Reserved	Reserved	Reserved	QE
Status	C0h	Reserved	Reserved	Reserved	Reserved	P_Fail	E_Fail	WEL	OIP
Block Protection	A0h	BPRWD[1]	Reserved	BP2	BP1	BP0	Invert	Complementary	SP[2]

Note 1: *If BPRWD is enabled and WP# is LOW, then the block protection register cannot be changed.*

Note 2: *SP bit is for Solid-protection. Once the SP bit sets as 1, the rest of the protection bits (BPx bits, Invert bits, complementary bits) cannot be changed during the current power cycle.*

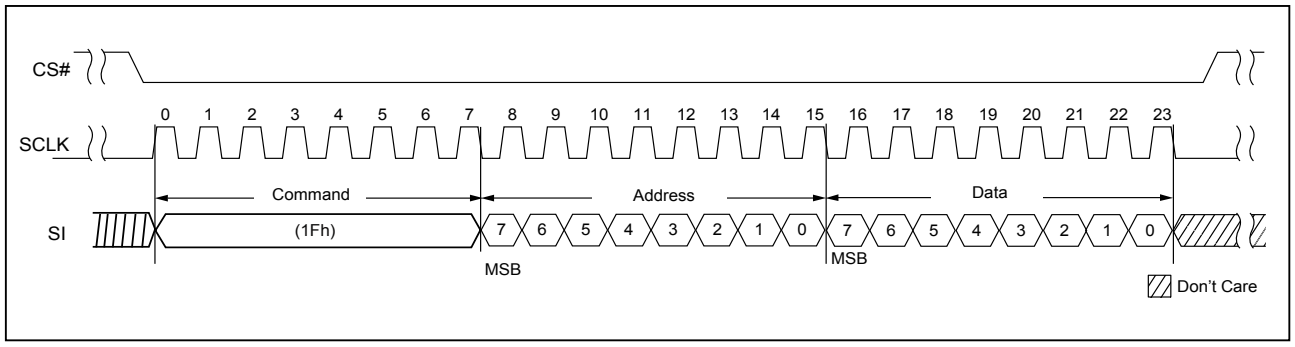
Note 3: *All the reserved bits must keep low including the undefined register.*

Figure 6. GET FEATURES (0Fh) Timing



深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

Figure 7. SET FEATURES (1Fh) Timing



8-3. READ Operations

The device supports "Power-on Read" function, after power up, the device will automatically load the data of the 1st page of 1st block from array to cache. The host micro-controller may directly read the 1st page of 1st block data from the cache buffer.

8-3-1. PAGE READ (13h)

The page read operation transfers data from array to cache by issuing the page read (13h)command followed by the 24-bit address (including the dummy/block/page address).

The device will have a period of time (tRD) being busy after the CS# goes high. The 0Fh (GET FEATURE) may be used to poll the operation status.

After read operation is completed, the RANDOM DATA READ (03H or 0Bh), Read from cache (x2) (3Bh), and Read from cache (x4) (6Bh) may be issued to fetch the data.

Wrap Read Operation

There are four wrap address bits which define the four wrap length as the table below. After the Read from cache command (03h, 0Bh, 3Bh, 6Bh), setting the wrap address bits, and followed by the 12-bit column address to define the starting address. The starting address for wrap read only can be 0 - 2111. The data will be output from the starting address, once it reaches the end of the boundary of wrap length, the data will be wrap around the beginning starting wrap address until CS# goes high.

Table 3. Wrap Address bit Table

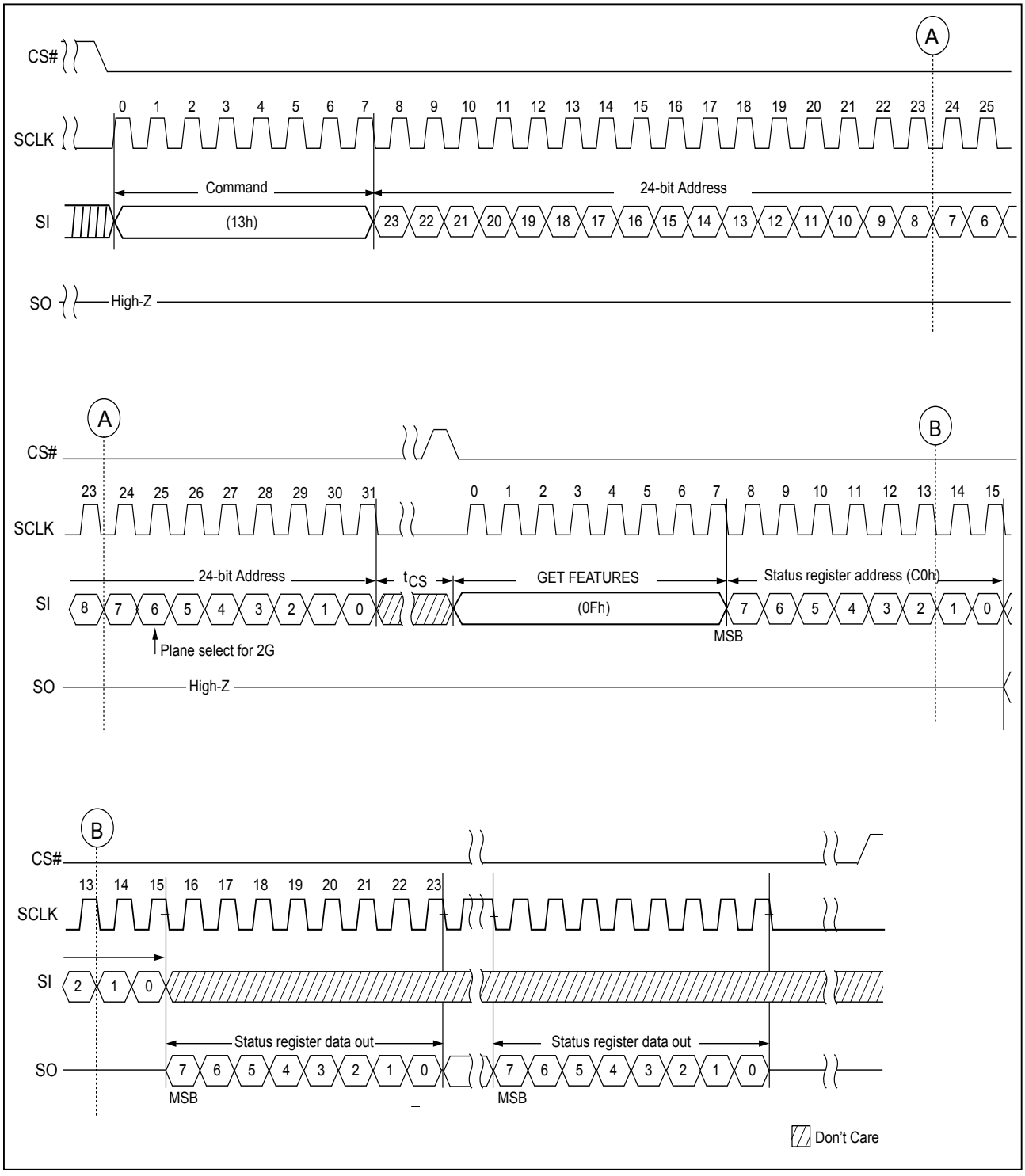
Wrap [1]	Wrap [0]	Wrap Length (byte)
0	0	2112
0	1	2048
1	0	64
1	1	16

8-3-2. QE bit

The Quad Enable (QE) bit, volatile bit, while it is "0" (factory default), it performs non-Quad and WP#, HOLD# are enabled. While QE is "1", it performs Quad I/O mode and WP#, HOLD# are disabled. In another word, if the system goes into four I/O mode (QE=1), the feature of Hardware Protection Mode(HPM) and HOLD will be disabled. Upon power recycle, the QE bit will go into the factory default setting "0".

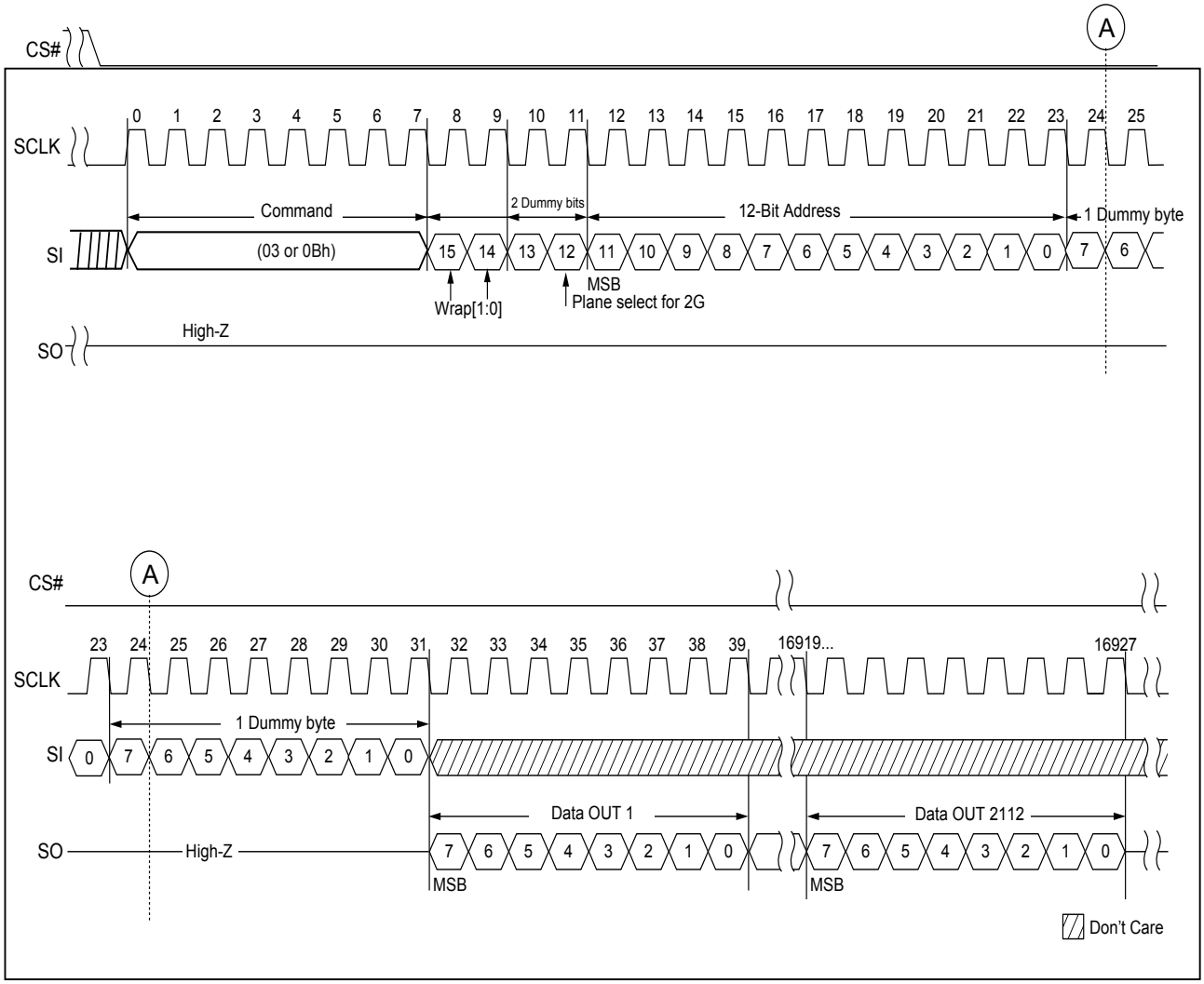
深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

Figure 8. PAGE READ (13h) Timing x1



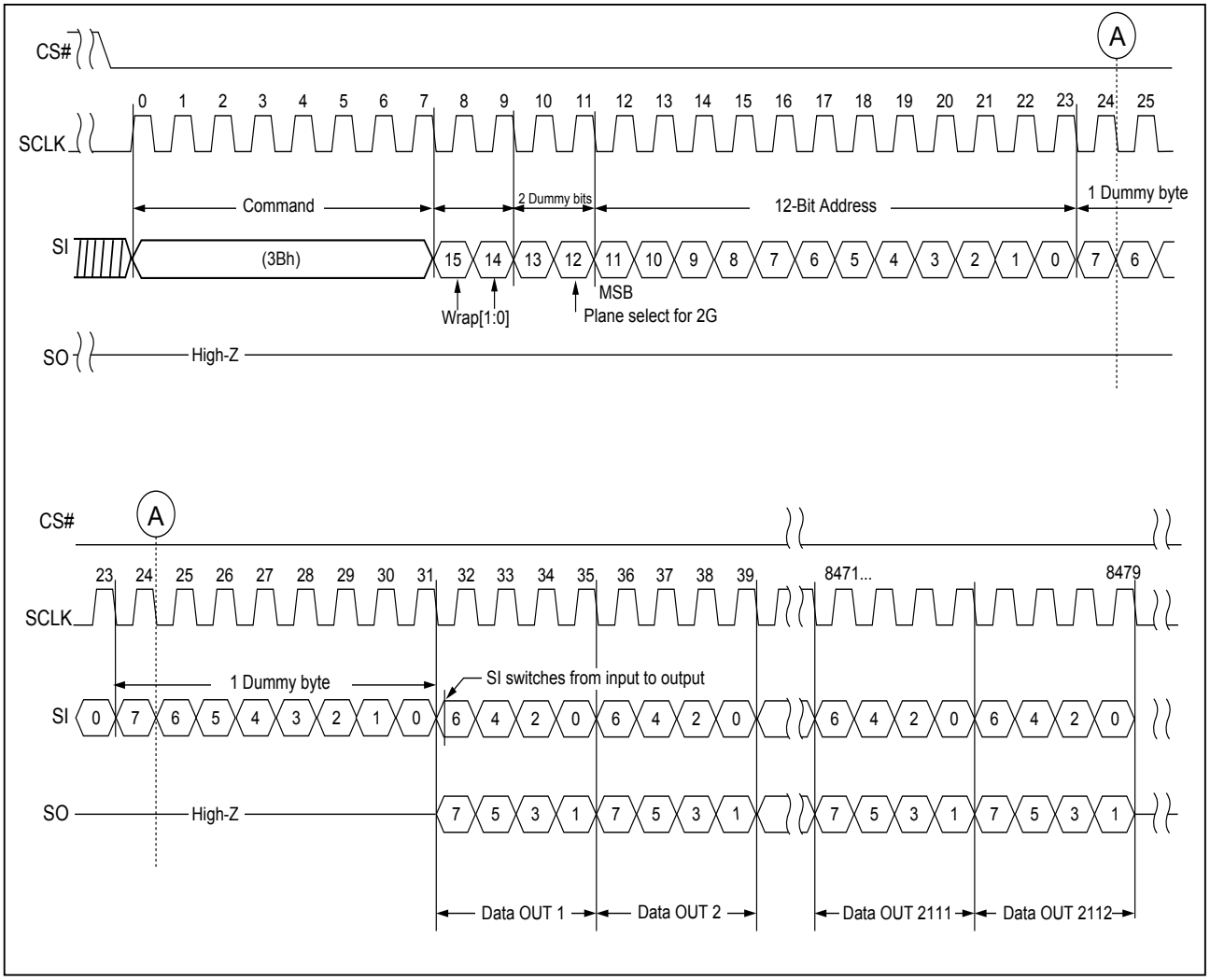
深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

Figure 9. RANDOM DATA READ (03h or 0Bh) Timing



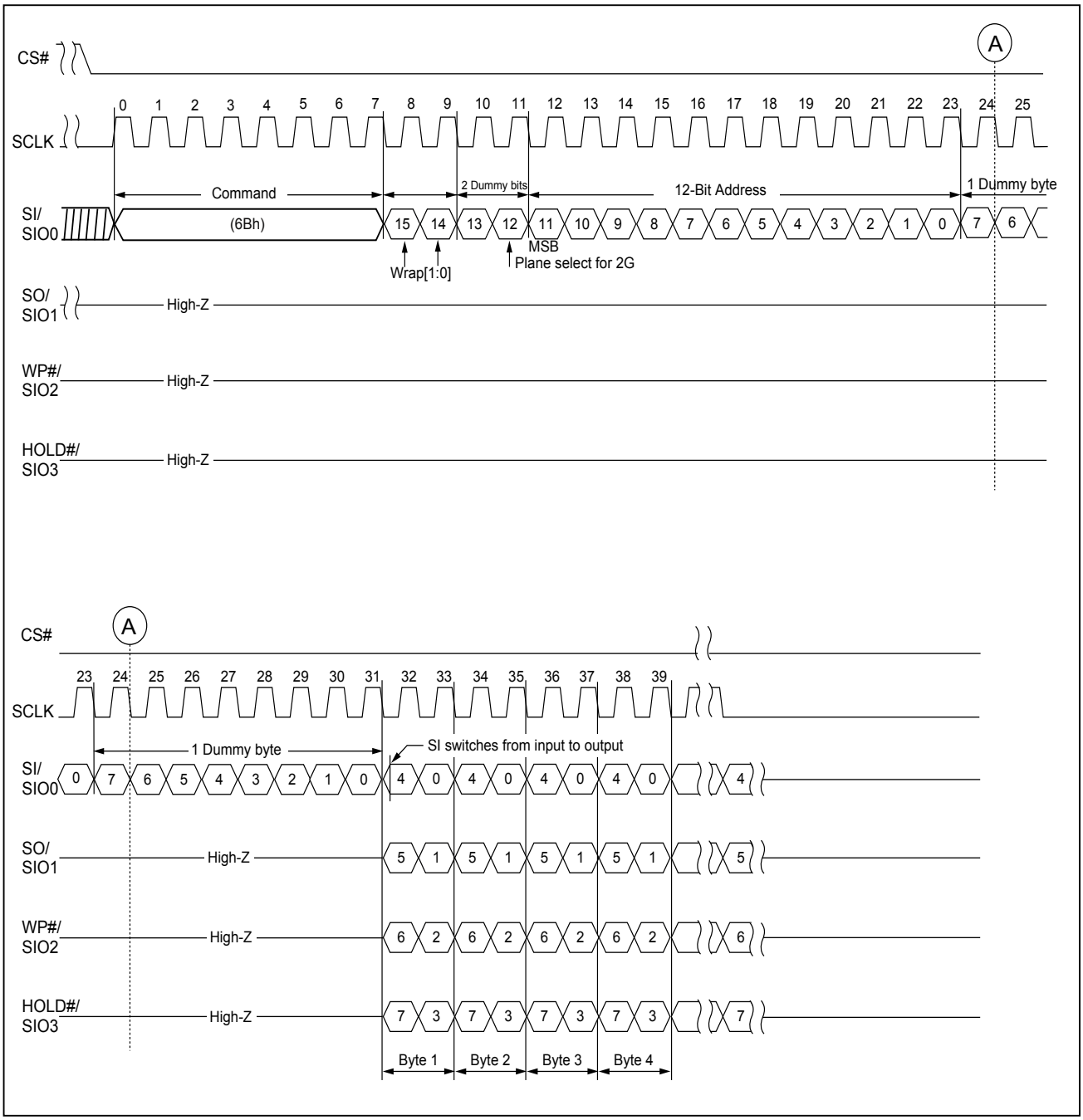
深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

Figure 10. READ FROM CACHE x 2



深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

Figure 11. READ FROM CACHE x 4



深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

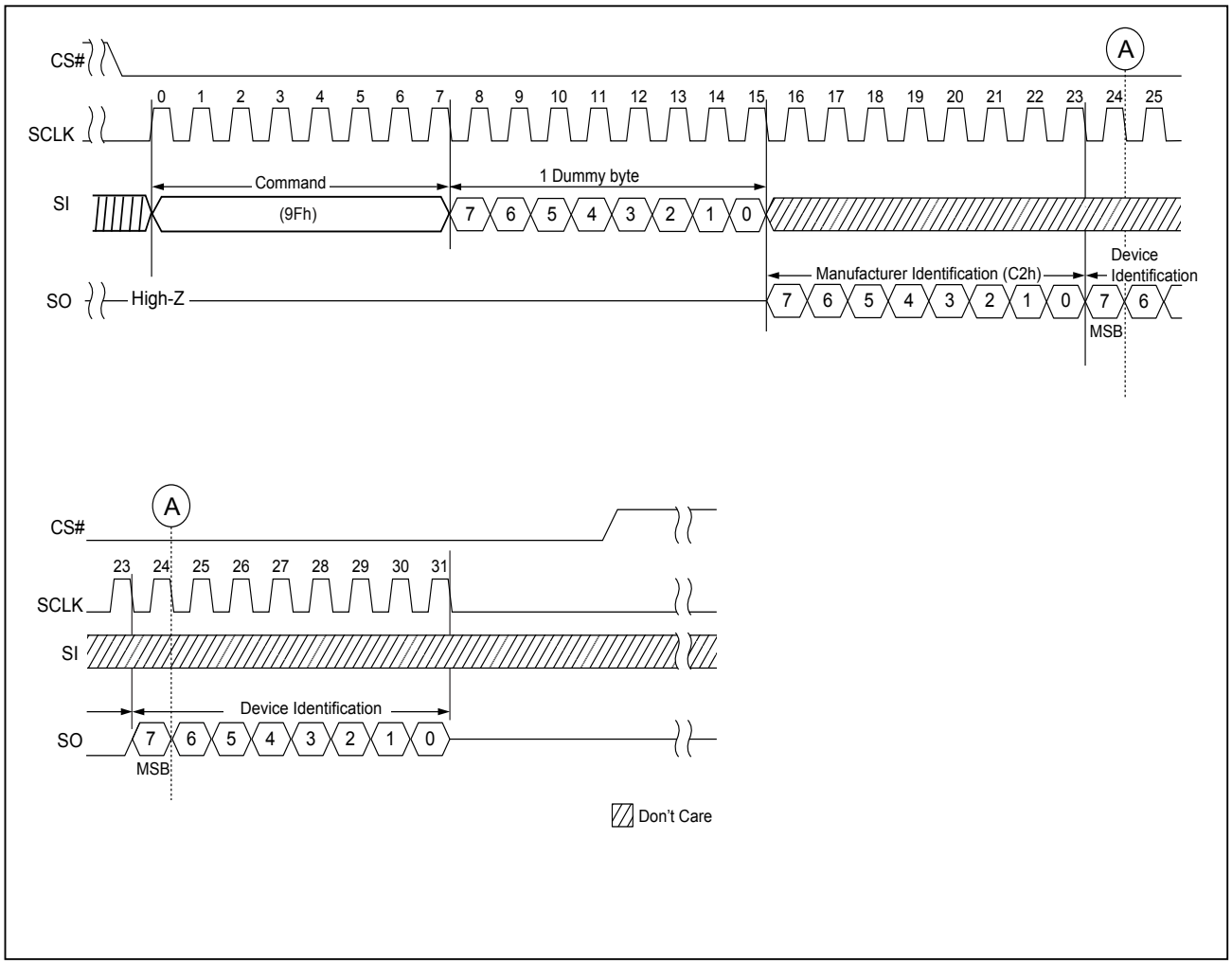
8-3-3. READ ID (9Fh)

The READ ID command is shown as the table below.

Table 4. READ ID Table

Byte	Description	I/O7	I/O6	I/O5	I/O4	I/O3	I/O2	I/O1	I/O0	Value
Byte 0	Manufacturer ID (Macronix)	1	1	0	0	0	0	1	0	C2h
Byte 1	Device ID (Serial NAND)	1	0	0	1	0	0	0	0	90h (for 1Gb)
		1	0	1	0	0	0	0	0	A0h (for 2Gb)

Figure 12. READ ID (9Fh) Timing



深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

8-4. Parameter Page

The parameter page is accessed by the following command flows:

Issue 1Fh (SET FEATURE) command with Secure OTP enable (B0h for address & 40h for data) --> Issue 13h (PAGE READ) with 01h address, issue 0Fh (GET FEATURE) with C0h function address to poll the status of read completion. --> Issue 03h (READ FROM CACHE) with address A[11:0]=000h and read data --> Issue 1Fh (SET FEATURE) with function address B0h to disable Secure OTP function (data byte = 10h or 00h) [exit parameter page read].

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

8-5. Parameter Page Data Structure Table

Table 5. Parameter Page Data Structure (For MX35UF1G14AC)

	Revision Information and Features Block		
Byte#	**Description**		**Data**
0-3	Parameter Page Signature		4Fh, 4Eh, 46h, 49h
4-5	Revision Number		00h, 00h
6-7	Features Supported (N/A)		00h, 00h
8-9	Optional Commands Supported		06h, 00h
10-31	Reserved		00h
	Manufacturer Information Block		
Byte#	**Description**		**Data**
32-43	Device Manufacturer (12 ASCII characters)		4Dh, 41h, 43h, 52h, 4Fh, 4Eh, 49h, 58h, 20h, 20h, 20h, 20h
44-63	Device Model (20 ASCII Characters)	MX35UF1G14AC	4Dh, 58h, 33h, 35h, 55h, 46h, 31h, 47h, 31h, 34h, 41h, 43h, 20h, 20h, 20h, 20h, 20h, 20h, 20h, 20h
64	Manufacturer ID		C2h
65-66	Date Code		00h, 00h
67-79	Reserved		00h

Memory Organization Block			
Byte#	**Description**		**Data**
80-83	Number of Data Bytes per Page	2048-byte	00h, 08h, 00h, 00h
84-85	Number of Spare Bytes per Page	64-byte	40h, 00h
86-89	Number of Data Bytes per Partial Page	512-byte	00h, 02h, 00h, 00h
90-91	Number of Spare Bytes per Partial Page	16-byte	10h, 00h
92-95	Number of Pages per Block		40h, 00h, 00h, 00h
96-99	Number of Blocks per Unit		00h, 04h, 00h, 00h
100	Number of Logical Units		01h
101	Number of Address Cycles (N/A)		00h
102	Number of Bits per Cell		01h
103-104	Bad Blocks Maximum per unit		14h, 00h
105-106	Block endurance		01h, 05h
107	Guarantee Valid Blocks at Beginning of Target		01h
108-109	Block endurance for guaranteed valid blocks		00h, 00h
110	Number of Programs per Page		04h
111	Partial Programming Attributes		00h
112	Number of ECC bits		04h
113	Number of Interleaved Address Bits (N/A)		00h
114	Interleaved Operation Attributes (N/A)		00h
115-127	Reserved		00h

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

Electrical Parameters Block			
Byte#	**Description**		**Data**
128	I/O Pin Capacitance		0Ah
129-130	Timing Mode Support (N/A)		00h, 00h
131-132	Program Cache Timing (N/A)		00h, 00h
133-134	tPROG Maximum Page Program Time (uS)	600us	58h, 02h
135-136	BE Maximum Block Erase time (uS)	3500us	ACh, 0Dh
137-138	tRD Maximum Page Read time (uS)	25us	19h, 00h
139-140	tCCS Minimum (N/A)	0ns	00h, 00h
141-163	Reserved		00h
Vendor Blocks			
Byte#	**Description**		**Data**
164-165	Vendor Specific Revision Number		00h, 00h
166-253	Vendor Specific		00h
254-255	Integrity CRC		Set at Test ***(Note)***
Redundant Parameter Pages			
Byte#	**Description**		**Data**
256-511	Value of Bytes 0-255		Same as 0~255 Byte
512-767	Value of Bytes 0-255		Same as 0~255 Byte
768+	Additional Redundant Parameter Pages		

Note:

The Integrity CRC (Cycling Redundancy Check) field is used to verify that the contents of the parameters page were transferred correctly to the host. Please refer to ONFI 1.0 specifications for details.

The CRC shall be calculated using the following 16-bit generator polynomial:
$G(X) = X^{16} + X^{15} + X^2 + 1$

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

Table 6. Parameter Page Data Structure (For MX35UF2G14AC)

	Revision Information and Features Block		
Byte#	**Description**		**Data**
0-3	Parameter Page Signature		4Fh, 4Eh, 46h, 49h
4-5	Revision Number		00h, 00h
6-7	Features Supported (N/A)		00h, 00h
8-9	Optional Commands Supported		06h, 00h
10-31	Reserved		00h
	Manufacturer Information Block		
Byte#	**Description**		**Data**
32-43	Device Manufacturer (12 ASCII characters)		4Dh, 41h, 43h, 52h, 4Fh, 4Eh, 49h, 58h, 20h, 20h, 20h, 20h
44-63	Device Model (20 ASCII Characters)	MX35UF2G14AC	4Dh, 58h, 33h, 35h, 55h, 46h, 32h, 47h, 31h, 34h, 41h, 43h, 20h, 20h, 20h, 20h, 20h, 20h, 20h, 20h
64	Manufacturer ID		C2h
65-66	Date Code		00h, 00h
67-79	Reserved		00h

Memory Organization Block			
Byte#	**Description**		**Data**
80-83	Number of Data Bytes per Page	2048-byte	00h, 08h, 00h, 00h
84-85	Number of Spare Bytes per Page	64-byte	40h, 00h
86-89	Number of Data Bytes per Partial Page	512-byte	00h, 02h, 00h, 00h
90-91	Number of Spare Bytes per Partial Page	16-byte	10h, 00h
92-95	Number of Pages per Block		40h, 00h, 00h, 00h
96-99	Number of Blocks per Unit		00h, 08h, 00h, 00h
100	Number of Logical Units		01h
101	Number of Address Cycles (N/A)		00h
102	Number of Bits per Cell		01h
103-104	Bad Blocks Maximum per unit		28h, 00h
105-106	Block endurance		01h, 05h
107	Guarantee Valid Blocks at Beginning of Target		01h
108-109	Block endurance for guaranteed valid blocks		00h, 00h
110	Number of Programs per Page		04h
111	Partial Programming Attributes		00h
112	Number of ECC bits		04h
113	Number of Interleaved Address Bits (N/A)		00h
114	Interleaved Operation Attributes (N/A)		00h
115-127	Reserved		00h

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

Electrical Parameters Block			
Byte#	**Description**		**Data**
128	I/O Pin Capacitance		0Ah
129-130	Timing Mode Support (N/A)		00h, 00h
131-132	Program Cache Timing (N/A)		00h, 00h
133-134	tPROG Maximum Page Program Time (uS)	600us	58h, 02h
135-136	BE Maximum Block Erase time (uS)	3500us	ACh, 0Dh
137-138	tRD Maximum Page Read time (uS)	25us	19h, 00h
139-140	tCCS Minimum (N/A)	0ns	00h, 00h
141-163	Reserved		00h
Vendor Blocks			
Byte#	**Description**		**Data**
164-165	Vendor Specific Revision Number		00h, 00h
166-253	Vendor Specific		00h
254-255	Integrity CRC		Set at Test ***(Note)***
Redundant Parameter Pages			
Byte#	**Description**		**Data**
256-511	Value of Bytes 0-255		Same as 0~255 Byte
512-767	Value of Bytes 0-255		Same as 0~255 Byte
768+	Additional Redundant Parameter Pages		

Note:
The Integrity CRC (Cycling Redundancy Check) field is used to verify that the contents of the parameters page were transferred correctly to the host. Please refer to ONFI 1.0 specifications for details.

The CRC shall be calculated using the following 16-bit generator polynomial:
$G(X) = X^{16} + X^{15} + X^2 + 1$

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

8-6. UniqueID Page

The UniqueID page is accessed by the following command flows:

Issue 1Fh (SET FEATURE) command with Secure OTP enable (B0h for address & 40h for data) → Issue 13h (PAGE READ) with 00h address, issue 0Fh (GET FEATURE) with C0h function address to poll the status of read completion → Issue 03h (READ FROM CACHE) with address A[11:0]=000h and read data → Issue 1Fh (SET FEATURE) with function address B0h to disable Secure OTP function (data byte =10h or 00h) [exit unique ID read]

UniqueID data: 16x32byte of UniqueID data. On each 32byte, the first 16byte and following 16byte should be XOR to be FFh.

8-7. Program Operations

8-7-1. PAGE PROGRAM

With following operation sequences, the PAGE PROGRAM operation programs the page from byte 1 to byte 2112.

WRITE ENABLE (06h) → PROGRAM LOAD (02h) --> PROGRAM LOAD RANDOM DATA (84h) if needed → PROGRAM EXECUTE (10h) → GET FEATUR from command to read status (0Fh).

WEL bit is set with the WRITE ENABLE (06h) issued. The program operation will be ignored if 06h command not issued. In a single page, four partial page programs are allowed. Exceeded bytes (Page address is larger than 2112) for "PROGRAM LOAD" or "PROGRAM LOAD RANDOM DATA", the exceeding bytes will be ignored. When CS goes high, the "PROGRAM LOAD" or "PROGRAM LOAD RANDOM DATA" operation" terminates. Please note **"Figure 13. PROGRAM LOAD (02h) Timing"** and **"Figure 14. PROGRAM LOAD RANDOM DATA (84h) Timing"**below for PROGRAM LOAD.

After PROGRAM LOAD is done, the programming of data should be as following steps: issue 10h (PROGRAM EXECUTE) with 1byte command code, 24 bits address --> code programming to memory and busy for tPROG → Program complete.

During programming, status to be polled by the status register. The OIP bit is "1" during the tPROG timing, and is cleared to "0" when Program Cycle is completed, and the Write Enable Latch (WEL) bit is cleared

Operation shows in the Figure below.

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

Figure 13. PROGRAM LOAD (02h) Timing

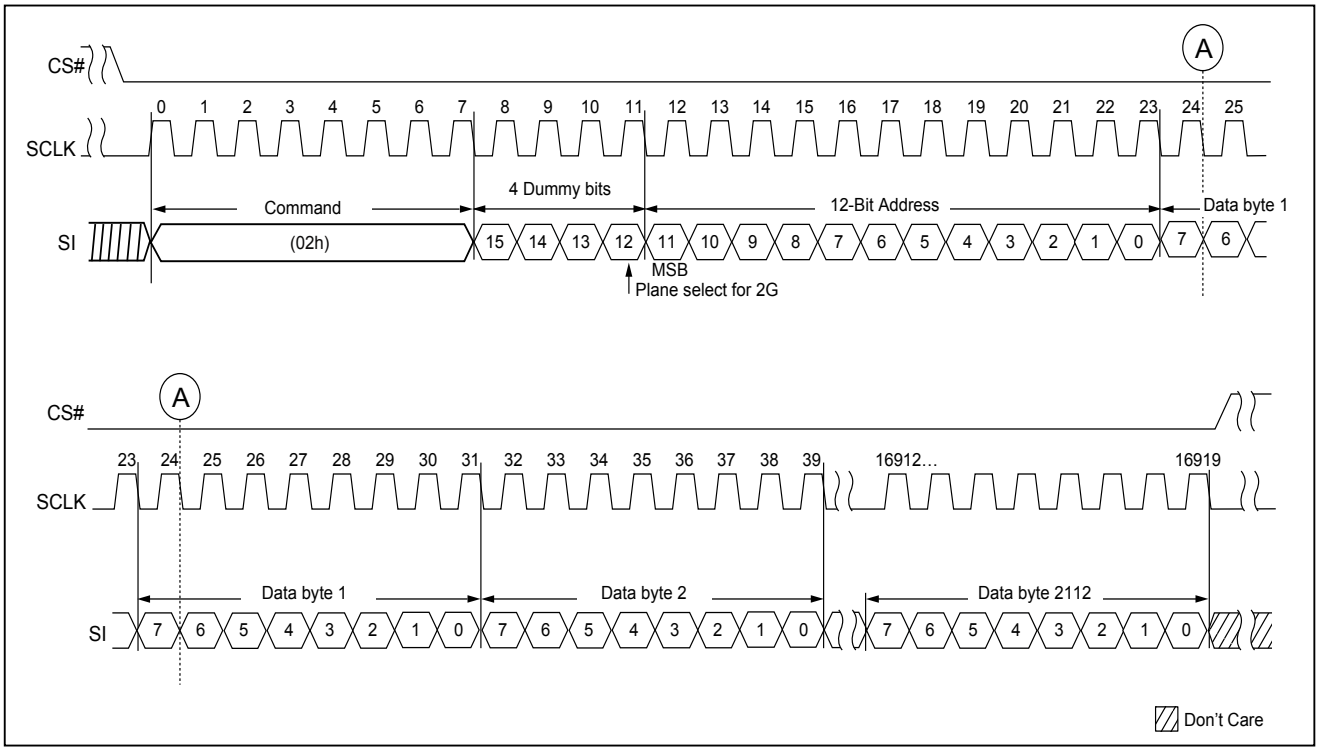
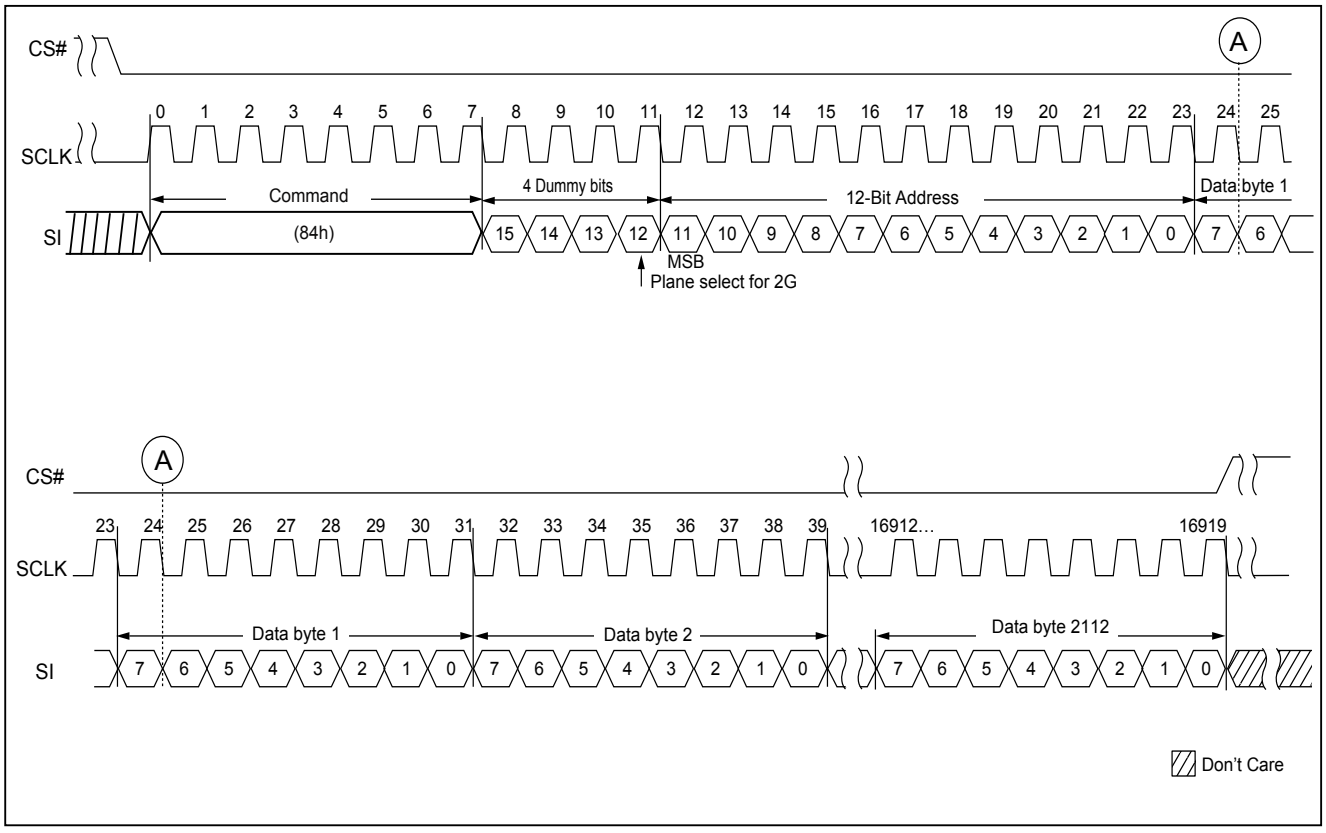


Figure 14. PROGRAM LOAD RANDOM DATA (84h) Timing

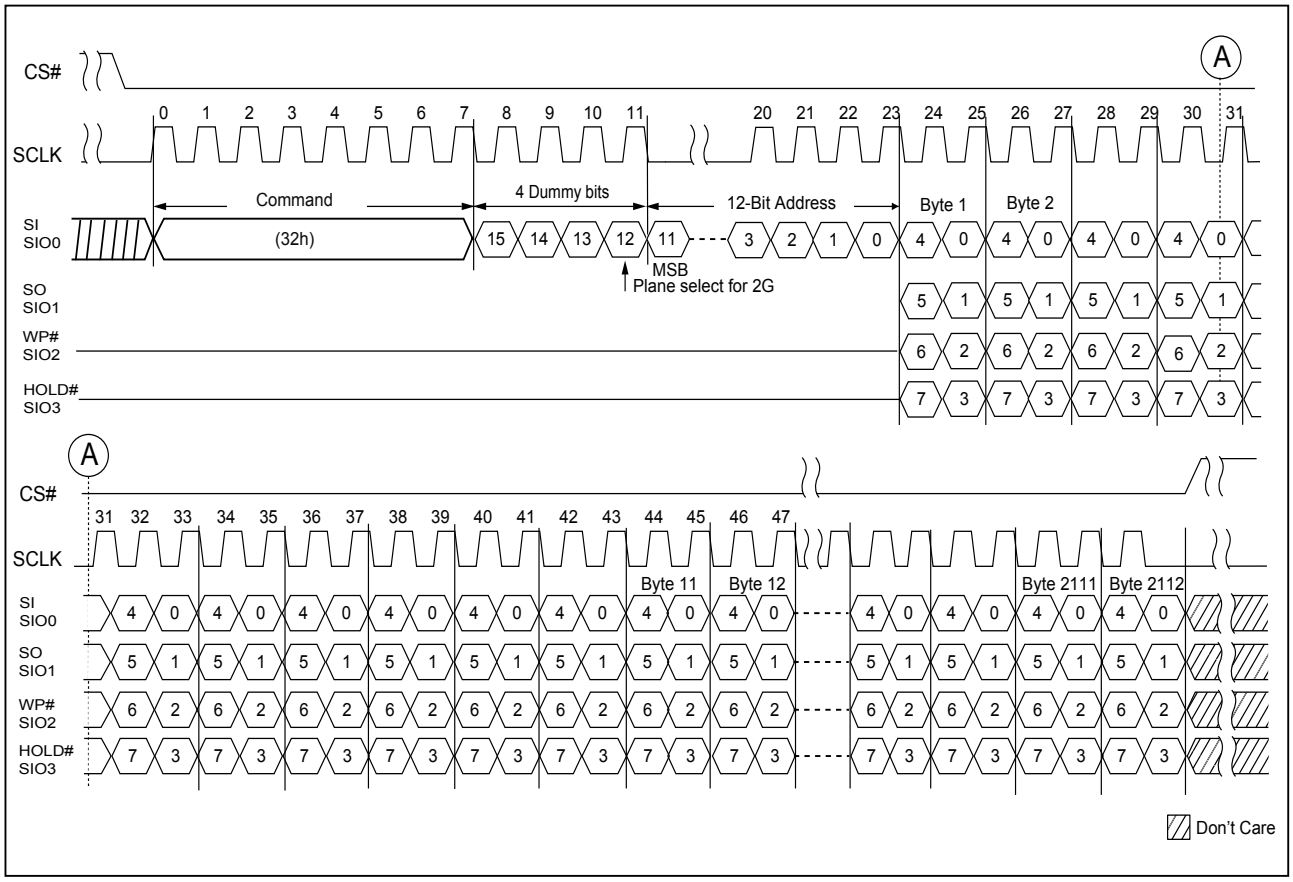


深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

8-7-2. QUAD IO PAGE PROGRAM

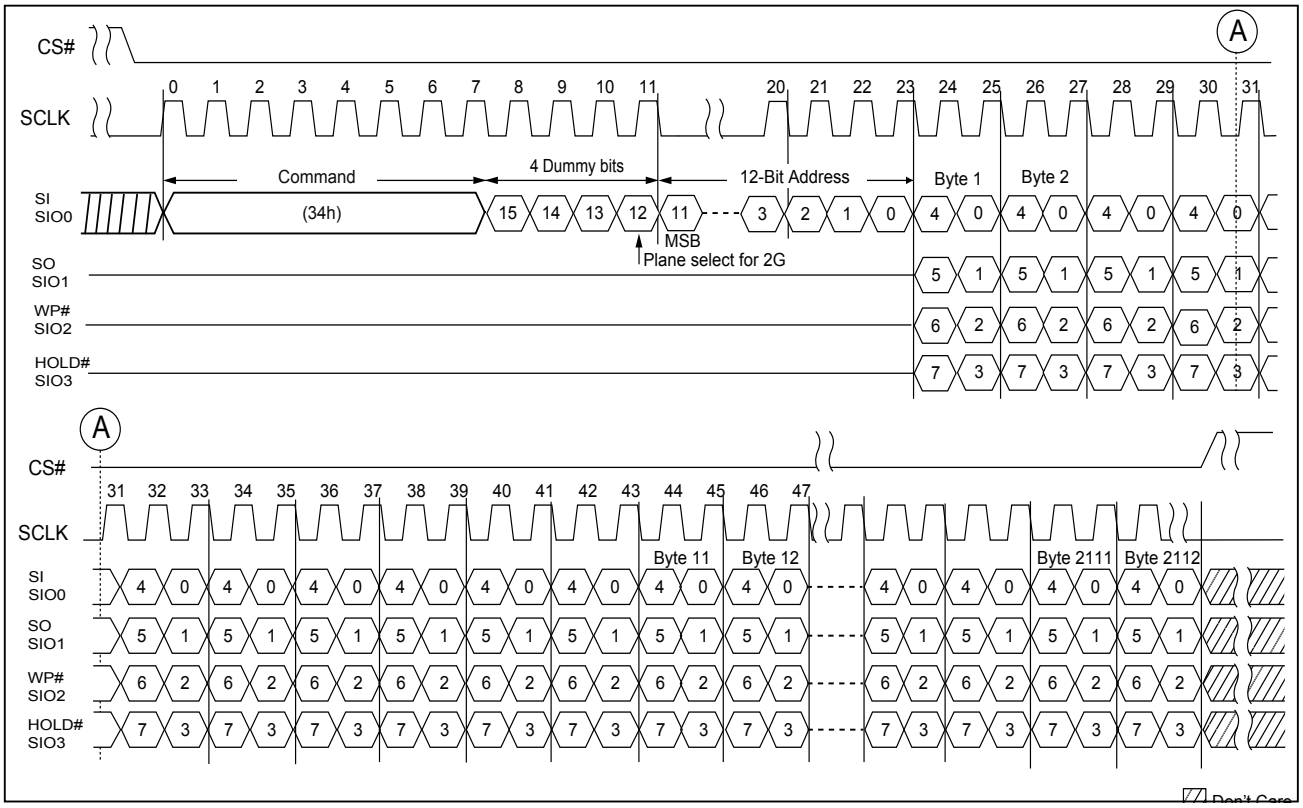
QUAD IO PAGE PROGRAM conducts the 2Kbyte program with 4 I/O mode. The steps are: WRITE ENABLE (06h) → PROGRAM LOAD X4 (32h) → PROGRAM LOAD RANDOM DATA (34h) if needed → PROGRAM EXECUTE (10h) → Poll status by issuing GET FEATURE (0Fh).

Figure 15. PROGRAM LOAD X4 (32h) Timing



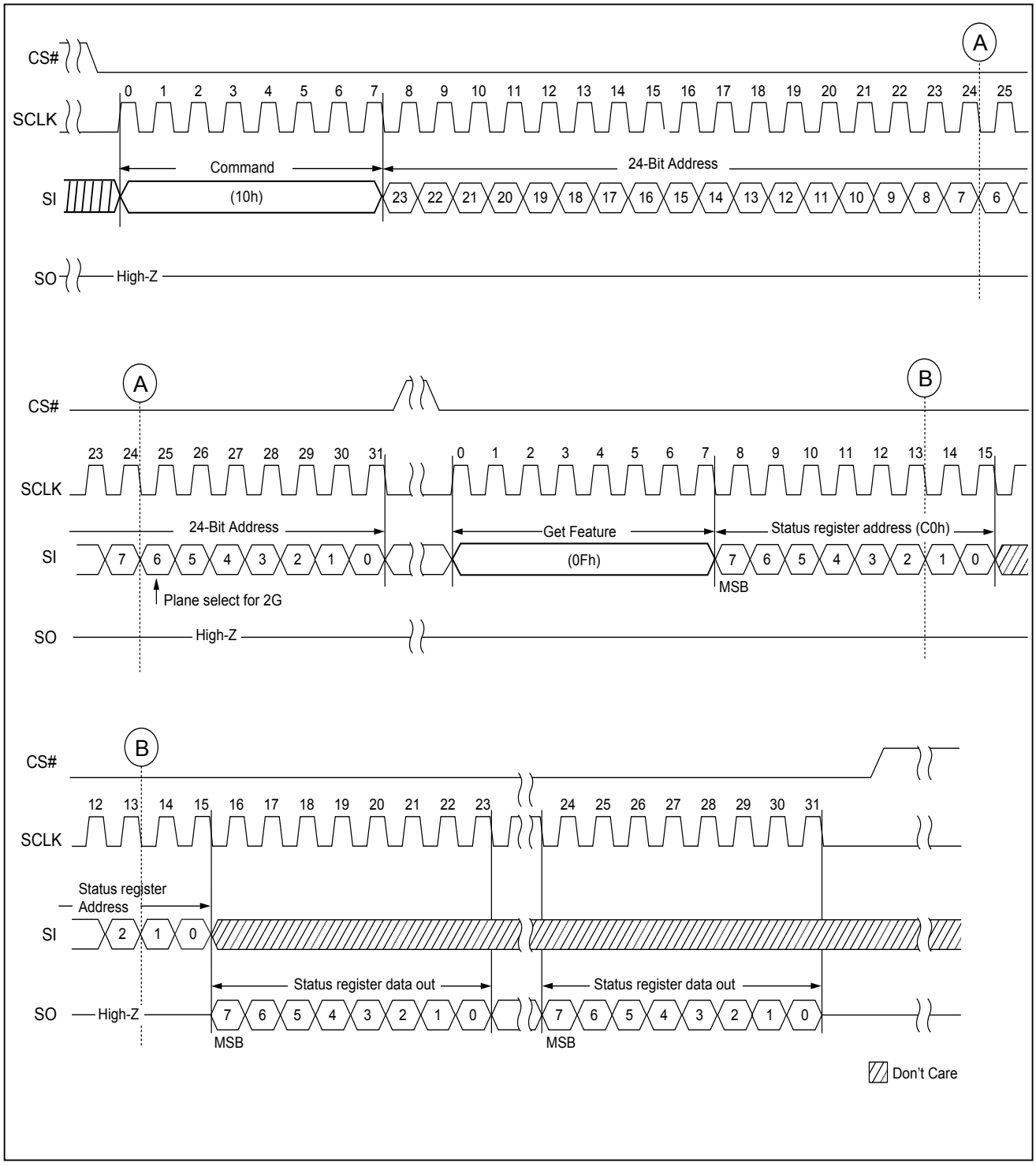
深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

Figure 16. QUAD IO PROGRAM RANDOM INPUT (34h) Timing



深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

Figure 17. PROGRAM EXECUTE (10h) Timing



深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

9. BLOCK OPERATIONS

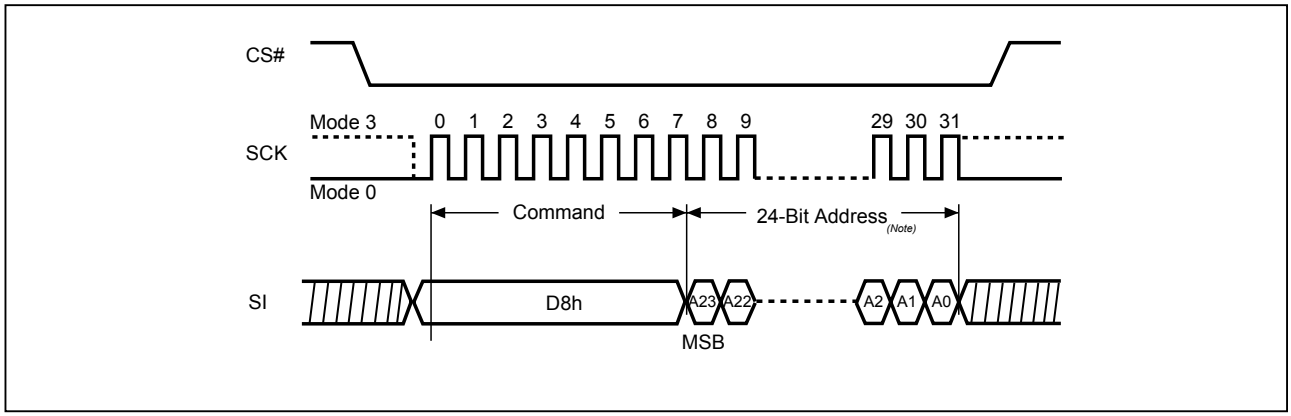
9-1. Block Erase (D8h)

The Block Erase (D8h) instruction is for erasing the data of the chosen block to be "1". The instruction is used for a block of 128K-byte erase operation. A Write Enable (WREN) instruction be executed to set the Write Enable Latch (WEL) bit before sending the Block Erase (D8h). Any address of the block is a valid address for Block Erase (D8h) instruction. The CS# must go high exactly at the byte boundary (the least significant bit of address byte been latched-in); otherwise, the instruction will be rejected and not executed. Finally, a Get Feature(0Fh) instruction to check the status is necessary.

The sequence of issuing Block Erase instruction is: CS# goes low→ sending Block Erase instruction code→ 24-bit address on SI→CS# goes high.

The self-timed Block Erase Cycle time (tBE) is initiated as soon as Chip Select (CS#) goes high. The Get Feature (0Fh) instruction with Address (C0h) may check the status of the operation during the Block Erase cycle is in progress (please refer to the **"Figure 6. GET FEATURES (0Fh) Timing"** and **"Table 2. Features Settings"**). The OIP bit is "1" during the tBE timing, and is cleared to "0" when Block Erase Cycle is completed, and the Write Enable Latch (WEL) bit is cleared.

Figure 18. Block Erase (BE) Sequence



Note: *The 24-bit Address includes: 17-bit row address and 7-bit dummy (for 2Gb), or 16-bit row address and 8-bit dummy (for 1Gb).*

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

9-2. Feature Register

Feature register defines various register's definitions (Block Protection, Secure OTP, Status register). The definition of each register is as **"Table 7. Definition of Protection Bits"** below:

9-2-1. Block Protection Feature

The Block Protection feature includes three block protection bits (BPx), Block Protection Register Write Disable (BPRWD), Inverse bit (INVERT), complement bit (COMPLEMENTARY) and Solid Protection Bit (SP).

Soft Protection Mode (SPM)

The SPM uses the BPx bits, INVERT, and COMPLEMENTARY bits to allow part of memory to be protected as read only. The protected area definition is shown as **"Table 7. Definition of Protection Bits"**, the protected areas are more flexible which may protect various area by setting value of BP0-BP2 and Invert bit, and Complementary bit. These are volatile bits and can be modified by set feature command.

After power-up, the chip is in protection state, that is, the feature bits BPx is 1, all other bits (BPRWD, INVERT, COMPLEMENTARY and SP) are 0. The Set feature instruction (1Fh) with feature address (A0h) may change the value of the block protection bits and un-protect whole chip or a certain area for further program/erase operation. For example, after the power-on, the whole chip is protected from program/erase operation, the top 1/64 area may be un-protected by using the Set feature instruction (1Fh) with the feature address (A0h) to change the values of BP2 and BP1 from "1" to "0" as **"Table 7. Definition of Protection Bits"**.

Hardware Protection Mode (HPM) & Solid Protection Mode (SDPM)

Under the Hardware Protection mode and Solid Protection Mode, the (BPx, INVERT, COMPLEMENTART) bits can not be changed.

Hardware Protection Mode: The device enters HPM if BPRWD bits is set to 1 and WP#/SIO2 is driven to 0.

Note 1: *HPM also requires SP bit to be 0 state.*

Note 2: *The Quad mode is not supported in HPM.*

Solid Protection Mode: If SP bit is set to 1, the device enters SDPM. After that, the selected block is solid protected and can not be un-protected until next power cycle.

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

Table 7. Definition of Protection Bits

BP2	BP1	BP0	Invert	Complementary	Protection Area
0	0	0	x	x	all unlocked
0	0	1	0	0	upper 1/64 locked
0	1	0	0	0	upper 1/32 locked
0	1	1	0	0	upper 1/16 locked
1	0	0	0	0	upper 1/8 locked
1	0	1	0	0	upper 1/4 locked
1	1	0	0	0	upper 1/2 locked
1	1	1	x	x	all locked (default)
0	0	1	1	0	lower 1/64 locked
0	1	0	1	0	lower 1/32 locked
0	1	1	1	0	lower 1/16 locked
1	0	0	1	0	lower 1/8 locked
1	0	1	1	0	lower 1/4 locked
1	1	0	1	0	lower 1/2 locked
0	0	1	0	1	lower 63/64 locked
0	1	0	0	1	lower 31/32 locked
0	1	1	0	1	lower 15/16 locked
1	0	0	0	1	lower 7/8 locked
1	0	1	0	1	lower 3/4 locked
1	1	0	0	1	block 0
0	0	1	1	1	upper 63/64 locked
0	1	0	1	1	upper 31/32 locked
0	1	1	1	1	upper 15/16 locked
1	0	0	1	1	upper 7/8 locked
1	0	1	1	1	upper 3/4 locked
1	1	0	1	1	block0

***Note**: Block #0 is at lower portion.*

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

9-2-2. Secure OTP (One-Time-Programmable) Feature

There is an Secure OTP area which has 30 full pages (30 x 2112-byte) from page 02h to page 1Fh guarantee to be good for system device serial number storage or other fixed code storage. The Secure OTP area is a non-erasable and one-time-programmable area, which is default to “1” and allows partial page program to be “0”, once the Secure OTP protection mode is set, the Secure OTP area becomes read-only and cannot be programmed again.

The Secure OTP operation is operated by the Set Feature instruction with feature address (B0h) to access the Secure OTP operation mode and Secure OTP protection mode.

To check the NAND device is ready or busy in the Secure OTP operation mode, the status register bit 0 (OIP bit) may report the status by Get Feature command operation.

To exit the Secure OTP operation or protect mode, it can be done by writing "0" to both Bit7 ("Secure OTP Protect" Bit) and bit6 ("Secure OTP Enable" Bit) for returning to the normal operation.

Secure OTP Read

1. Issuing the Set Feature instruction (1Fh)
2. Sending the Feature address (B0h) and set the "Secure OTP Enable" Bit as "1".
3. Issuing normal Page Read command (13h)

Secure OTP Program (if the "Secure OTP Protect" Bit is "0")

1. Issuing the Set Feature instruction (1Fh)
2. Sending the Feature address (B0h) and set the "Secure OTP Enable" Bit as "1".
3. Issuing Page Program command (02h)
4. Issuing program execute command (10h)

Secure OTP Protection

1. Issuing the Set Feature instruction (1Fh)
2. Sending the Feature address (B0h) and set both the "Secure OTP Protect" Bit and "Secure OTP Enable" Bit as "1".
3. Issuing program execute command (10h)

Table 8. Secure OTP States

Secure OTP Protect Bit[Note1]	Secure OTP Enable Bit	State
0	0	Normal operation
0	1	Access the Secure OTP for reading or programming
1	0	Not applicable
1	1	Secure OTP Protection by using the Program Execution command (10h)[Note2]

Note 1. *"Secure OTP Protect" Bit is non-volatile.*

Note 2. *Once the "Secure OTP Protect" Bit and "Secure OTP Enable" Bit are set as "1", the Secure OTP becomes read only.*

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

9-2-3. Status Register

The MX35UFxG14AC provides a status register that outputs the device status by writing a Get Feature command (0Fh) with the feature address (C0h), and then the IO pins output the status.

The Get Feature (0Fh) command with the feature address(C0h) will keep the device at the status read mode unless next valid command is issued. The resulting information is outlined in the table below.

Table 9. Status Register Bit Descriptions

SR Bit	Bit Name	Description
SR[0] (OIP)	Operation in progress	The bit value indicates whether the device is busy in operations of read/ program execute/ erase/ reset command. 1: Busy, 0: Ready
SR[1] (WEL)	Write enable latch	The bit value indicates whether the device is set to internal write enable latch. When WEL bit sets to 1, which means the internal write enable latch is set, and then the device can accept program/ erase/secure OTP program operation. 1: write enable, 0: not write enable The bit value will be cleared (as "0") by issuing Write Disable command(04h) or the completion of program/erase/secure OTP program operations.
SR[2] (ERS_Fail)	Erase fail	The bit value shows the status of erase failure or if host erase any invalid address or protected area (including protected blocks or protected Secure OTP area). 0: Passed, 1: Failed The bit value will be cleared (as "0") by RESET command or at the beginning of the block erase command operation.
SR[3] (PGM_Fail)	Program fail	The bit value shows the status of program failure or if host program any invalid address or protected area (including protected blocks or protected Secure OTP area). 0: Passed, 1: Failed The bit value will be cleared (as "0") by RESET command or during the program execute command operation.
SR[7:4]	Reserved	

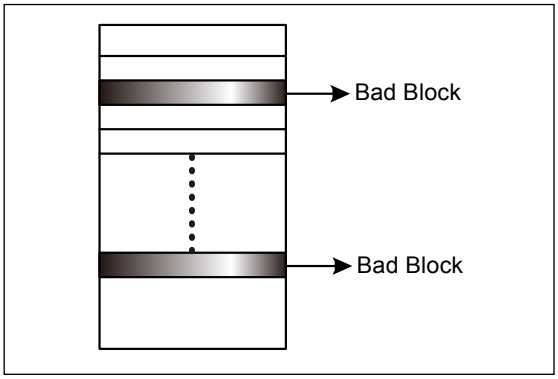
深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

10. SOFTWARE ALGORITHM

10-1. Invalid Blocks (Bad Blocks)

The bad blocks are included in the device while it gets shipped. During the time of using the device, the additional bad blocks might be increasing; therefore, it is necessary to check the bad block marks and avoid using the bad blocks. Furthermore, please read out the bad block information before any erase operation since the bad block marks may be cleared by any erase operation.

Figure 19. Bad Blocks



While the device is shipped, the value of all data bytes of the good blocks are FFh. The 1st byte of the 1st and 2nd page in the spare area for bad block will be 00h. The erase operation at the bad blocks is not recommended.

After the device is installed in the system, the bad block checking is recommended. The figure of **"Figure 20. Bad Block Test Flow"** shows the brief test flow by the system software managing the bad blocks while the bad blocks were found. When a block gets damaged, it should not be used any more.

Due to the blocks are isolated from bit-line by the selected gate, the performance of good blocks will not be impacted by bad ones.

Table 10. Valid Blocks

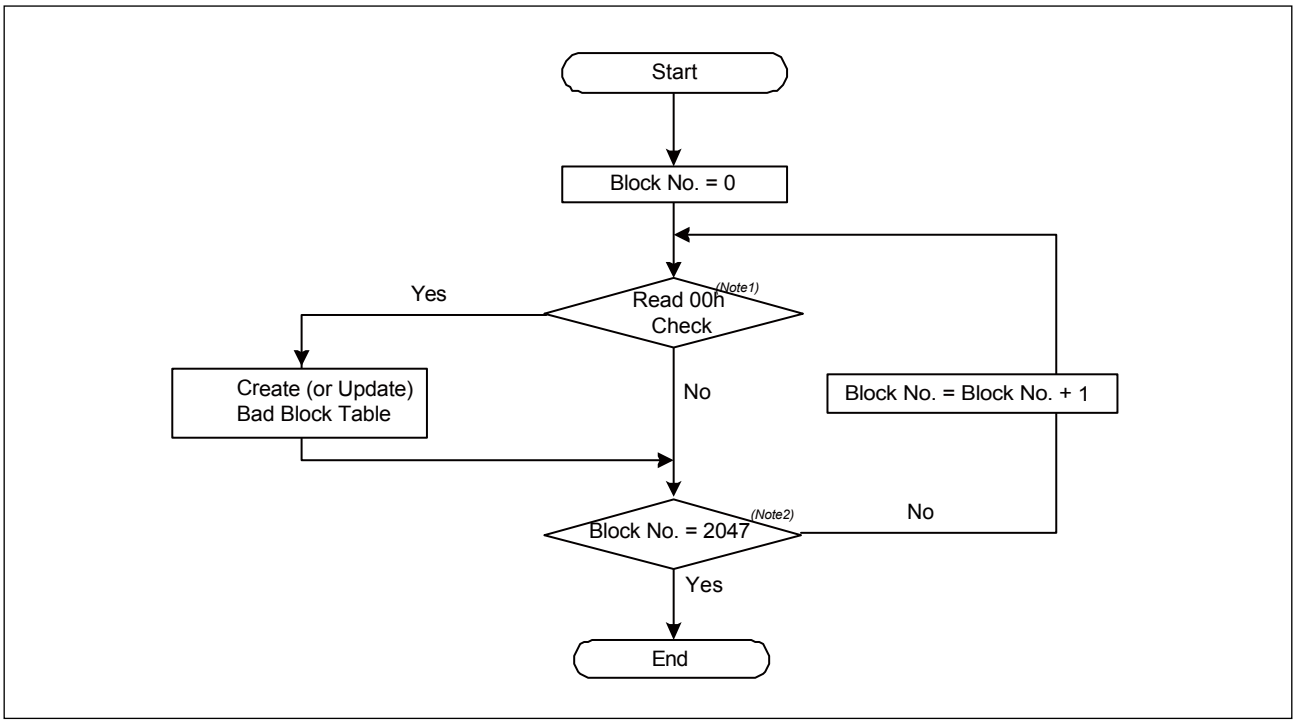
	Density	Min.	Typ.	Max.	Unit	Remark
Valid (Good) Block Number	1Gb	1004		1024	Block	Block 0 is guaranteed to be good (with ECC)
	2Gb	2008		2048		

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

10-2. Bad Block Test Flow

Although the initial bad blocks are marked by the flash vendor, they could be inadvertently erased and destroyed by a user that does not pay attention to them. To prevent this from occurring, it is necessary to always know where any bad blocks are located. Continually checking for bad block markers during normal use would be very time consuming, so it is highly recommended to initially locate all bad blocks and build a bad block table and reference it during normal NAND flash use. This will prevent having the initial bad block markers erased by an unexpected program or erase operation. Failure to keep track of bad blocks can be fatal for the application. For example, if boot code is programmed into a bad block, a boot up failure may occur. The following figure of **Bad Block Test Flow** shows the recommended flow for creating a bad block table.

Figure 20. Bad Block Test Flow



Note 1: *Read 00h check is at the 1st byte of the 1st and 2nd pages of the block spare area.*

Note 2: *The Block No. = 1023 for 1Gb, 2047 for 2Gb.*

10-3. Failure Phenomena for Read/Program/Erase Operations

The device may fail during a Read, Program or Erase operation. The following possible failure modes should be considered when implementing a highly reliable system:

Table 11. Failure Modes

Failure Mode	Detection and Countermeasure	Sequence
Erase Failure	Status Read after Erase	Block Replacement
Programming Failure	Status Read after Program	Block Replacement
Read Failure	Read Failure	ECC

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

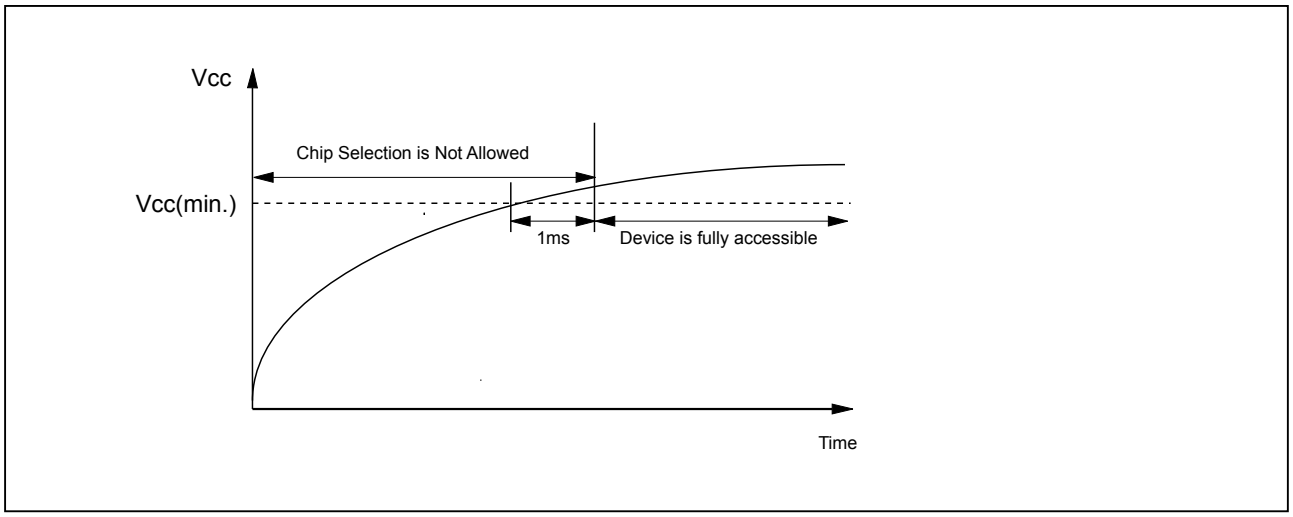
11. DEVICE POWER-UP

11-1. Power-up

After the Chip reaches the power on level, the internal power on reset sequence will be triggered. During the internal power on reset period, no any external command is accepted. The device can be fully accessible when VCC reaches the power-on level and wait 1mS.

During the power on and power off sequence, it is necessary to keep the WP# = Low for internal data protection.

Figure 21. Power On Sequence



深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

12. PARAMETERS

12-1. ABSOLUTE MAXIMUM RATINGS

Temperature under Bias	-50°C to +125°C
Storage temperature	-65°C to +150°C
All input voltages with respect to ground (Note 2)	-0.6V to 2.4V
VCC supply voltage with respect to ground (Note 2)	-0.6V to 2.4V
ESD protection	>2000V

Notes:

1. *The reliability of device may be impaired by exposing to extreme maximum rating conditions for long range of time.*
2. *Permanent damage may be caused by the stresses higher than the "Absolute Maximum Ratings" listed.*
3. *During voltage transitions, all pins may overshoot to VCC +1.0V or -1.0V for period up to 20ns.*

See the two waveforms as below.

Figure 23. Maximum Negative Overshoot Waveform

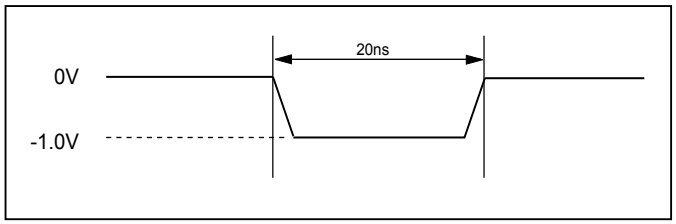


Figure 22. Maximum Positive Overshoot Waveform

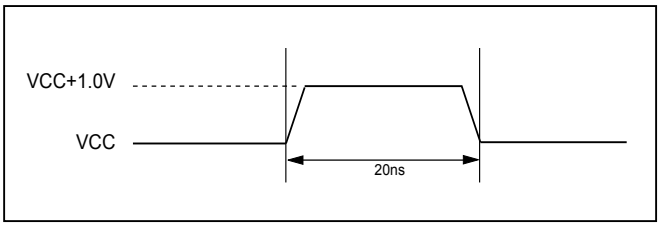


Table 12. AC Testing Conditions

Testing Conditions	Value	Unit
Input pulse level	0 to VCC	V
Output load capacitance	1TTL+CL(30)	pF
Input rising & falling time	2.5	ns
Input timing measurement reference levels	VCC/2	V
Output timing measurement reference levels	VCC/2	V

Table 13. Capacitance

TA = +25°C, F = 1 MHz

Symbol	Parameter	Min.	Typ.	Max.	Units	Conditions
CIN	Input capacitance			10	pF	VIN = 0V
COUT	Output capacitance			10	pF	VOUT = 0V

Table 14. Operating Range

Temperature	VCC	Tolerance
-40°C to + 85°C	1.8V	1.7 to 1.95V

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

Table 15. DC Characteristics

Symbol	Parameter	Min.	Typical	Max.	Unit	Test Conditions
ILI	Input leakage current			+/- 10	uA	VIN= 0 to VCC Max.
ILO	Output leakage current			+/- 10	uA	VOUT= 0 to VCC Max.
ISB	VCC standby current (CMOS)		10	50	uA	VIN=VCC or GND, CS#=VCC
ICC1	VCC active current (Sequential Read)		23	30	mA	f=104MHz
ICC2	VCC active current (Program)		23	30	mA	
ICC3	VCC active current (Erase)		15	30	mA	
VIL	Input low level	-0.3		0.2VCC	V	
VIH	Input high level	0.8VCC		VCC + 0.3	V	
VOL	Outout low voltage			0.1	V	IOL= -100uA
VOH	Outout high voltage	VCC-0.1			V	IOH= 100uA

Table 16. General Timing Characteristics

Symbol	Parameter	Min.	Max.	Unit
fC	Clock Frequency	-	104	MHz
tCHHH	HOLD# high hold time relative to SCLK	5	-	ns
tCHHL	HOLD# low hold time relative to SCLK	5	-	ns
tCS	Command diselect time	100	-	ns
tCHSH	Chip select# hold time	4	-	ns
tSLCH	Chip select# setup time	4	-	ns
tSHCH	Chip select# non-active setup time	4		ns
tCHSL	Chip select# non-active hold time	4		ns
tDIS	Output disable time	-	20	ns
tHC	Hold# non-active setup time relative to SCLK	5	-	ns
tHD	Hold# setup time relative to SCLK	5	-	ns
tHDDAT	Data input hold time	3.5	-	ns
tHO	Output hold time	1	-	ns
tHZ	Hold to output High-Z	-	15	ns
tLZ	Hold to output low-Z	-	15	ns
tSUDAT	Data input setup time	3.5	-	ns
tV	Clock LOW to output Valid	-	8	ns
tWH	Clock HIGH time	4	-	ns
tWL	Clock LOW time	4	-	ns
tWPH	WP# hold time	100	-	ns
tWPS	WP# setup time	20	-	ns

Table 17. PROGRAM/READ/ERASE Characteristics

Symbol	Parameter	Min	Typ.	Max.	Unit
tRD	Data transfer time from NAND Flash array to data register.		-	25	us
tRST	Device reset time (Read/ Program/ Erase)		-	5/10/500	us
tPROG	Page programming time		320	600	us
tERS	Block Erase Time		1	3.5	ms
NOP	Number of partial-page programming operation supported		-	4	cycle

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

Figure 24. WP# Setup Timing and Hold Timing during SET FEATURE when BPRWD=1

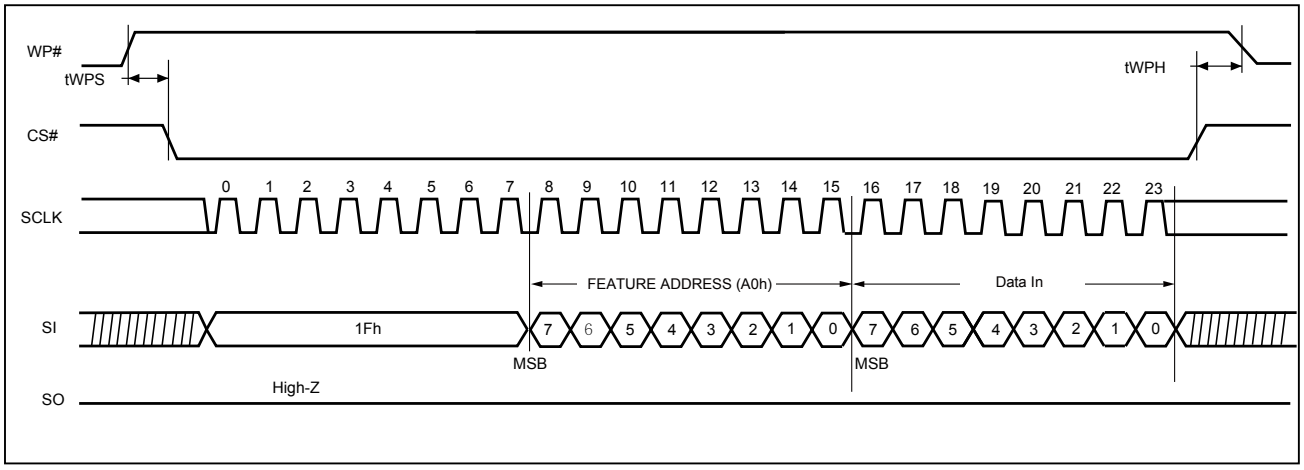


Figure 25. Serial Input Timing

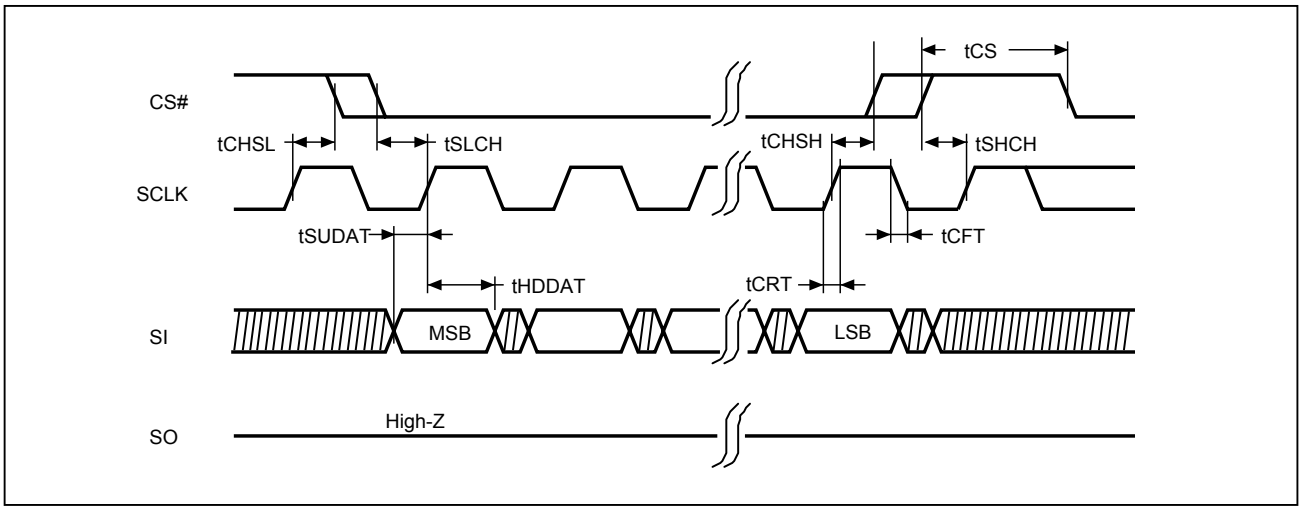
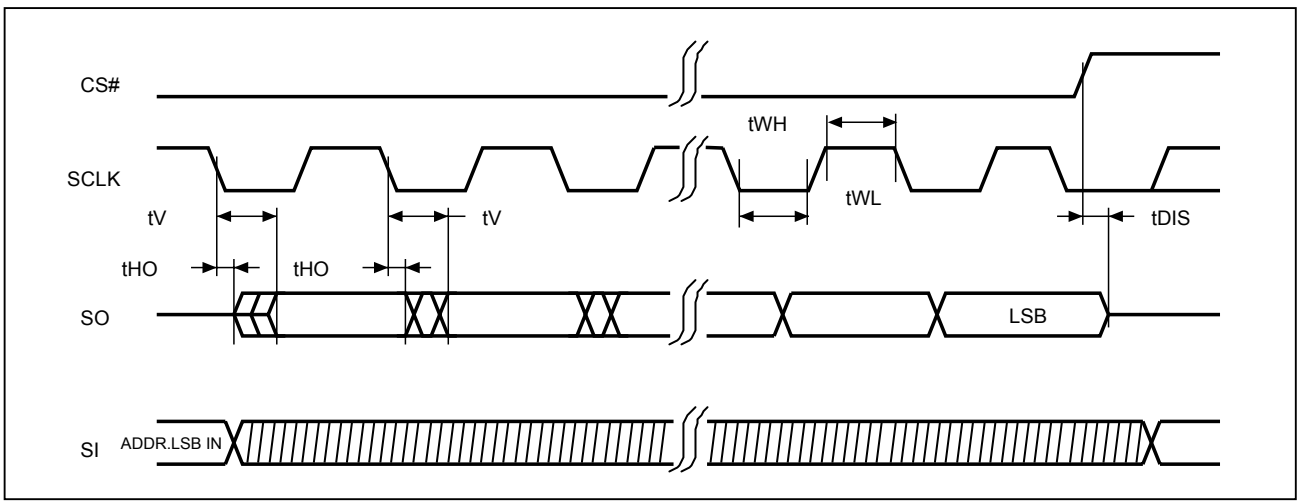
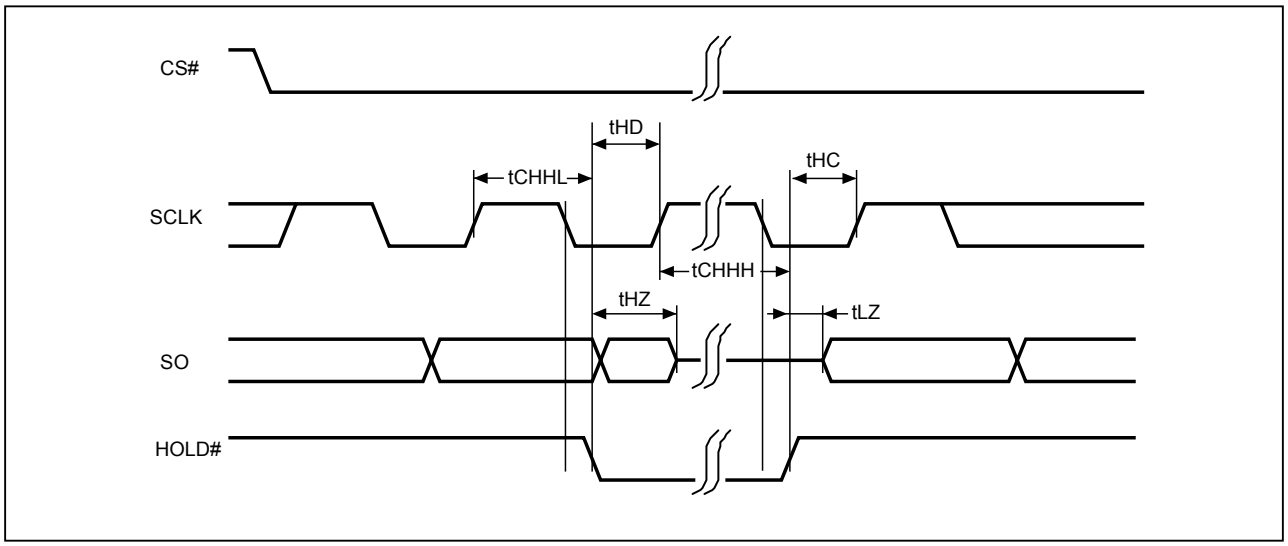


Figure 26. Serial Output Timing



深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

Figure 27. Hold Timing

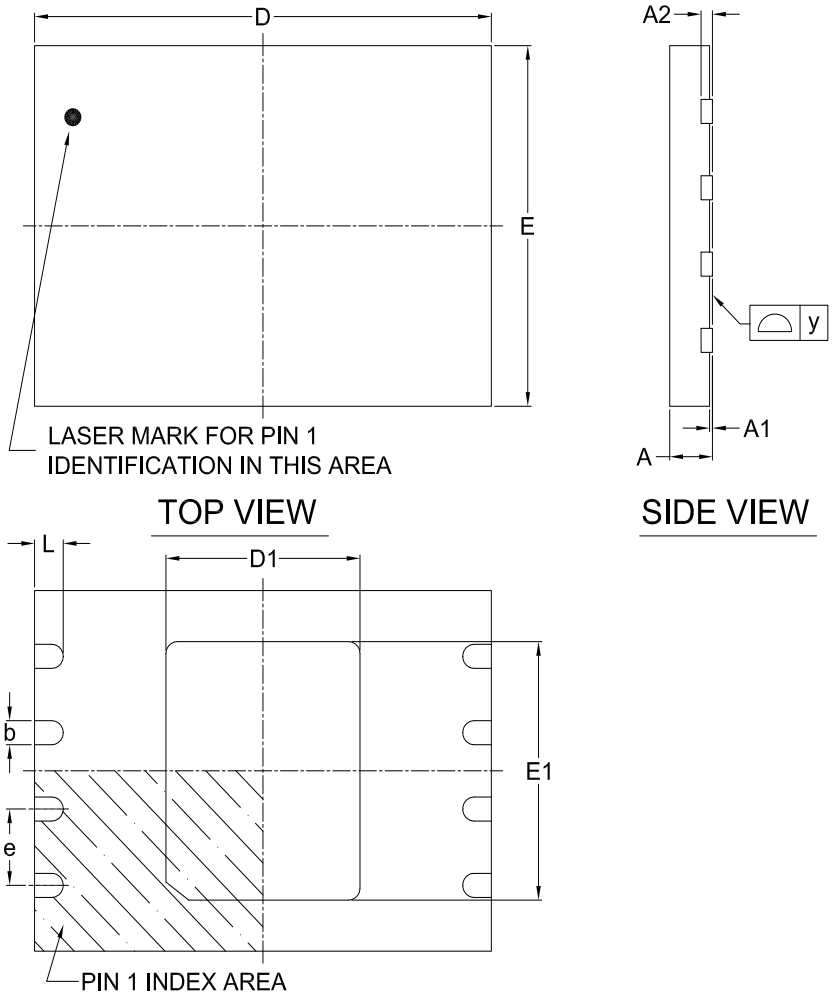


Note: *SI is "don't care" during HOLD operation.*

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

13. PACKAGE INFORMATION

Doc. Title: Package Outline for WSON 8L (8x6x0.8MM, LEAD PITCH 1.27MM, E.P. 3.4x4.3MM)



Note:

This package has an exposed metal pad underneath the package. It is recommended to leave the metal pad floating or to connect it to the same grou as the GND pin of the package. Do not connect the metal pad to any other voltage or signal line on the PCB. Avoid placing vias or traces underneath the metal pad. Connection of this metal pad to any other voltage or signal line can result in shorts and/or electrical malfunction of the device.

Dimensions (inch dimensions are derived from the original mm dimensions)

SYMBOL / UNIT		A	A1	A2	b	D	D1	E	E1	L	e	y
mm	Min.	0.70	—	---	0.35	7.90	3.35	5.90	4.25	0.45	---	0.00
	Nom.	---	—	0.20	0.40	8.00	3.40	6.00	4.30	0.50	1.27	---
	Max.	0.80	0.05	---	0.48	8.10	3.45	6.10	4.35	0.55	---	0.05
Inch	Min.	0.028	---	---	0.014	0.311	0.132	0.232	0.167	0.018	---	0.00
	Nom.	---	---	0.008	0.016	0.315	0.134	0.236	0.169	0.020	0.05	—
	Max.	0.032	0.002	---	0.019	0.319	0.136	0.240	0.171	0.022	---	0.002

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

14. REVISION HISTORY

Revision	Descriptions	Page
October 08, 2014		All
0.00	1. Initial Released	
August 25, 2016		
0.01	1. Supplementary of the host ECC requirement	P5,6
	2. Supplementary of the dual /quad mode as "1-1-2" & "1-1-4"	P5,8
	3. Added reliability spec of P/E endurance and data retention	P5
	4. Revised package type from Z2 to Z4.	P7,40
	5. Corrected byte44-63 of parameter page	P21
	6. Supplement the block#0 condition	P33
	7. Revised the bad block mark from non-FFh to 00h, also revised the page of bad block mark from 1st or 2nd page to 1st and 2nd page, and the figure of bad block test flow.	P34
	8. Added overshoot/undershoot waveforms	P36
	9. Added the value of input rising/falling time	P36
	10. Corrected the value of Cin/Cout	P36
	11. Corrected the typical value of ISB/ICC1/ICC2/ICC3. Corrected the VOL/VOH value	P37
	12. Corrected Min. column of Program/Read/Erase Characteristics Table as Typ. column and tRST value is corrected as Max.	P37
January 17, 2017		
0.02	1. Added new features for Page Read Cache Sequential	P5,11,19-21,40
June 06, 2017		
0.03	1. Part name renamed from MX35UF1G14AB to MX35UFxG14AC	ALL
	2. Re-wording the reset command effect on the feature setting	P13
	3. Renamed the register of address B0h from "Secure OTP" to "Configuration"	P13
	4. Tighten parameter timing of tCHSH/tSLCH/tSHCH/tCHSL from 5ns to 4ns and tWH/tWL from 4.5 to 4	P40
September 14, 2017		
0.04	1. Added 2Gb specifications	ALL
	2. Supplement of the WEL clear after completion of program/erase/secure OTP program operation	P12, 25
	3. Removed the specifications of Page Read Cache Sequential	P5, 11
	4. Improved the tolerance for min./max. dimensions of D1, E1 and L Symbols in WSON 8L Package outline	P42
February 07, 2018		
1.0	1. Removed "Advanced Information" page title	ALL
	2. Corrected the symbol of voltage in ordering information section	Page 7
	3. Added "Macronix Proprietary" footnote	ALL

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

November 18, 2020

1.1	1. Correction of typo in Table 3. Wrap Address bit Table and 12-1. ABSOLUTE MAXIMUM RATINGS Table.	P14, 38
	2. Supplement Note 3 on Table 2.	P13

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

Except for customized products which have been expressly identified in the applicable agreement, Macronix's products are designed, developed, and/or manufactured for ordinary business, industrial, personal, and/or household applications only, and not for use in any applications which may, directly or indirectly, cause death, personal injury, or severe property damages. In the event Macronix products are used in contradicted to their target usage above, the buyer shall take any and all actions to ensure said Macronix's product qualified for its actual use in accordance with the applicable laws and regulations; and Macronix as well as it's suppliers and/or distributors shall be released from any and all liability arisen therefrom.

Copyright© Macronix International Co., Ltd. 2017-2020. All rights reserved, including the trademarks and tradename thereof, such as Macronix, MXIC, MXIC Logo, MX Logo, Integrated Solutions Provider, Nbit, Macronix NBit, HybridNVM, HybridFlash, HybridXFlash, XtraROM, KH Logo, BE-SONOS, KSMC, Kingtech, MXSMIO, Macronix vEE, RichBook, Rich TV, OctaBus, FitCAM, ArmorFlash. The names and brands of third party referred thereto (if any) are for identification purposes only.

For the contact and order information, please visit Macronix's Web site at: http://www.macronix.com

MACRONIX INTERNATIONAL CO., LTD. reserves the right to change product and specifications without notice.

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com